

## Dual LDO Regulator (ch1=300mA, ch2=100mA) with ON/OFF Switch

## GENERAL DESCRIPTION

The XC6419 series is a dual CMOS LDO regulator. The series features high accuracy, low output noise, high ripple rejection and low dropout and consists of a voltage reference, error amplifier, driver transistor, current limiter, thermal shutdown circuit and phase compensation circuit. Each output voltage is set independently by laser trimming and selectable in 0.05V increments within a range of 0.8 to 5.0V.

The EN function turns each output of the two regulators off independently. In this state, the electric charge at the output capacitor ( $C_L$ ) is discharged via the internal auto-discharge switch, and as a result the  $V_{OUT}$  voltage quickly returns to the  $V_{SS}$  level. The output stabilization capacitor ( $C_L$ ) is also compatible with low ESR ceramic capacitors. The high level of output stability is maintained even during frequent load fluctuations, due to the excellent transient response performance. VR1 and VR2 are completely isolated so that a cross talk during load fluctuations is minimized.

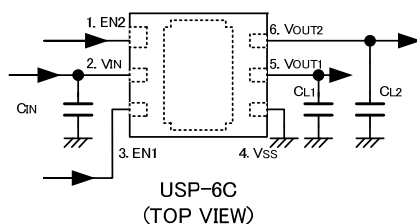
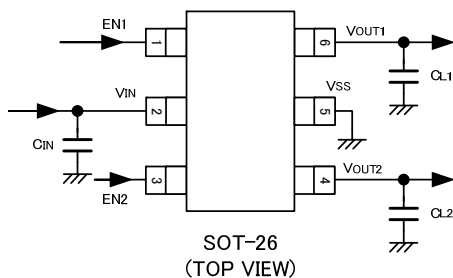
## APPLICATIONS

- Mobile phones
- Cordless phones, Wireless communication equipment
- Portable games
- Digital still cameras, Digital video cameras
- Portable audio equipment
- PDAs

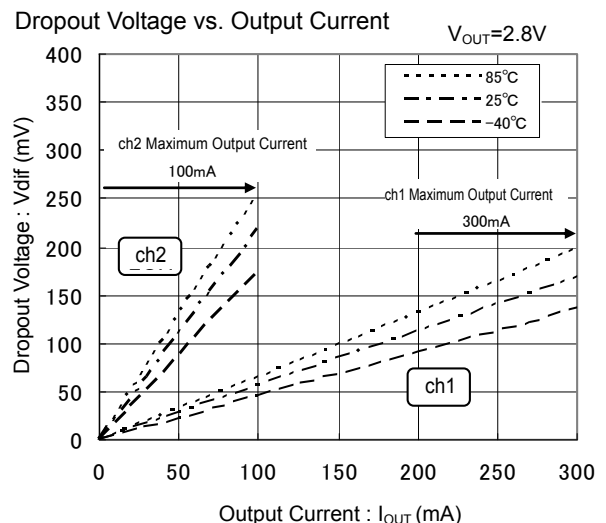
## FEATURES

Input Voltage Range	:	1.5~6.0V
Maximum Output Current	:	ch1.300mA / ch2.100mA
Output Voltage Range	:	0.8~5.0V
Output Accuracy	:	±1% (XC6419A/B) ±20mA@ $V_{OUT} \leq 2.0V$ ±2% (XC6419C/D) ±30mA@ $V_{OUT} \leq 1.5V$
Dropout Voltage ( $V_{OUT}=2.8V$ )	:	ch1.115mV@ $I_{OUT}=200mA$ ch2.115mV@ $I_{OUT}=50mA$
Low Power Consumption	:	ch1.28 $\mu A$ / ch2.23 $\mu A$
Stand-by Current	:	Less than 0.1 $\mu A$
Ripple Rejection	:	60dB@ $f=1kHz$
Current Limit	:	ch1.400mA / ch2.150mA
Low ESR Capacitor		
CL High Speed Discharge		
Small Packages	:	USP-6C, SOT-26

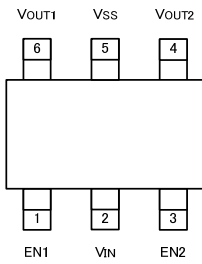
## TYPICAL APPLICATION CIRCUITS



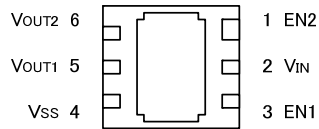
## TYPICAL PERFORMANCE CHARACTERISTICS



## PIN CONFIGURATION



SOT-26  
(TOP VIEW)



USP-6C  
(BOTTOM VIEW)

\*The dissipation pad for the USP-6C package should be solder-plated in recommended mount pattern and metal masking so as to enhance mounting strength and heat release. If the pad needs to be connected to other pins, it should be connected to the V<sub>SS</sub> (No. 4) pin.

## PIN ASSIGNMENT

PIN NUMBER		PIN NAME	FUNCTIONS
SOT-26	USP-6C		
1	3	EN1	: ON/OFF Control 1
2	2	V <sub>IN</sub>	: Power Input
3	1	EN2	: ON/OFF Control 2
4	6	V <sub>OUT2</sub>	: Output 2
5	4	V <sub>SS</sub>	: Ground
6	5	V <sub>OUT1</sub>	: Output 1

## PRODUCT CLASSIFICATION

Ordering Information

XC6419

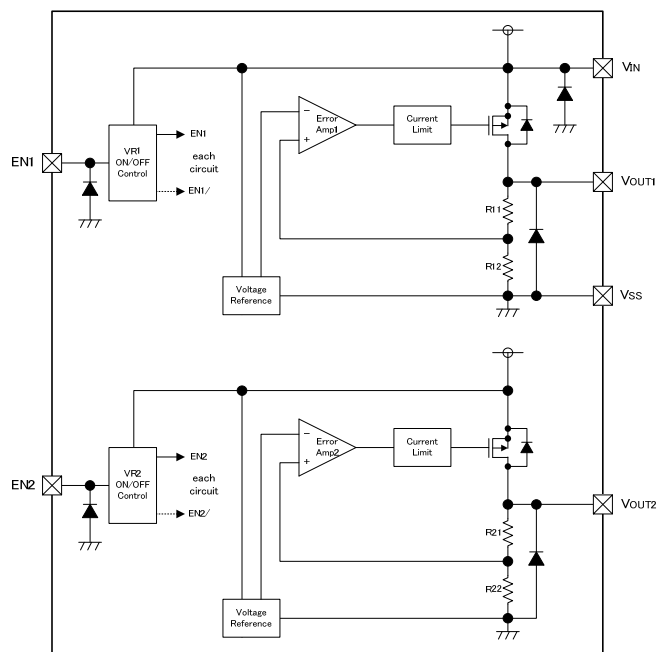
DESIGNATOR	DESCRIPTION	SYMBOL	DESCRIPTON
①	VR1	A	: EN High Active without C <sub>L</sub> auto discharge (Accuracy:1%)
		B	: EN High Active with C <sub>L</sub> auto discharge (Accuracy:1%)
		C	: EN High Active without C <sub>L</sub> auto discharge (Accuracy:2%)
		D	: EN High Active with C <sub>L</sub> auto discharge (Accuracy:2%)
②	VR2	A	: EN High Active without C <sub>L</sub> auto discharge (Accuracy:1%)
		B	: EN High Active with C <sub>L</sub> auto discharge (Accuracy:1%)
		C	: EN High Active without C <sub>L</sub> auto discharge (Accuracy:2%)
		D	: EN High Active with C <sub>L</sub> auto discharge (Accuracy:2%)
③④	Output Voltage	01~	: Sequential number showing VR1 and VR2 voltage combination VR1 range: 0.8 ~ 5.0V , VR2 range : 0.8 ~ 5.0V (0.05V increments) Refer to the table below
⑤	Packages	M	: SOT-26
		E	: USP-6C
⑥	Device Orientation	R	: Embossed tape, standard feed
		L	: Embossed tape, reverse feed

### DESIGNATOR

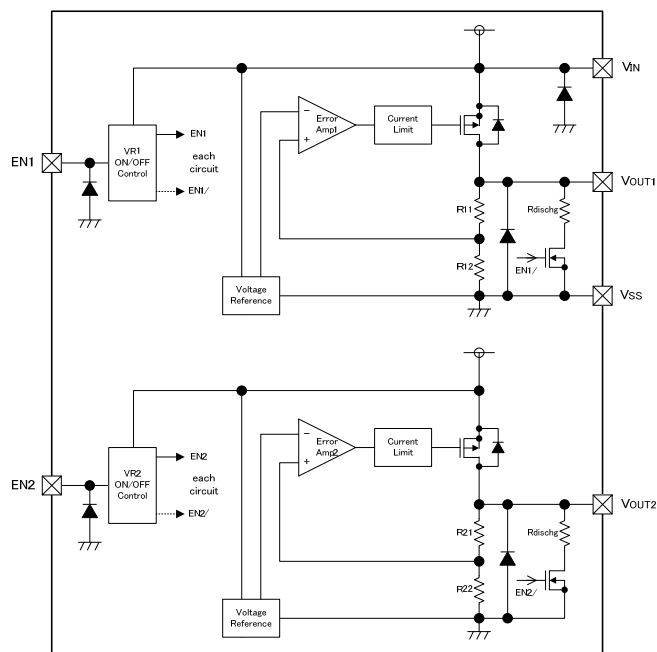
③④	VR1	VR2	③④	VR1	VR2	③④	VR1	VR2
01	1.80	2.80	11	1.30	1.50	21	1.50	2.80
02	1.20	2.90	12	2.80	2.80	22	1.80	3.00
03	1.80	1.80	13	2.50	3.30	23	1.85	2.80
04	1.50	2.70	14	3.00	3.30	24	1.85	3.30
05	2.85	2.85	15	1.20	1.80	25	2.60	2.80
06	1.80	3.30	16	2.80	3.30	26	1.50	1.50
07	3.00	3.00	17	3.30	3.30	27	2.00	3.00
08	2.80	1.80	18	3.10	3.10	28	3.30	1.80
09	1.20	1.20	19	2.80	1.50	29	3.30	1.75
10	1.10	1.30	20	1.30	2.80	30	2.10	4.10

\*For other combinations, please ask Torex sales contacts.

## BLOCK DIAGRAMS



< XC6419Aseries >



< XC6419Bseries >

\* Diodes inside the circuits are ESD protection diodes and parasitic diodes.

## ABSOLUTE MAXIMUM RATINGS

Ta=25°C

PARAMETER		SYMBOL	RATINGS	UNITS
Input Voltage		V <sub>IN</sub>	- 0.3 ~ + 6.5	V
Output Current		I <sub>OUT1</sub> +I <sub>OUT2</sub>	500 <sup>(*1)</sup>	mA
Output Voltage 1 / Output Voltage 2		V <sub>OUT1</sub> / V <sub>OUT2</sub>	V <sub>SS</sub> - 0.3 ~ V <sub>IN</sub> + 0.3	V
EN1/EN2 Input Voltage		V <sub>EN1</sub> / V <sub>EN2</sub>	V <sub>SS</sub> - 0.3 ~ + 6.5	V
Power Dissipation	USP-6C	Pd	120	mW
	SOT-26		1000 (PCB mounted) <sup>(*2)</sup>	
			250	
Operating Temperature Range		T <sub>opr</sub>	- 40 ~ + 85	°C
Storage Temperature Range		T <sub>stg</sub>	- 55 ~ + 125	°C

\*1: Please use within the range of Pd > { (V<sub>IN</sub>-V<sub>OUT1</sub>)×I<sub>OUT1</sub> + (V<sub>IN</sub>-V<sub>OUT2</sub>)×I<sub>OUT2</sub> }

\*2: This power dissipation figure shown is PCB mounted and is for reference only. Please refer to page 28 for details.

## ELECTRICAL CHARACTERISTICS

XC6419 Series

Regulator 1

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Output Voltage	$V_{OUT(E)}^{(*)2}$	$V_{OUT(T)} \geq 2.0V$ (A, B Series), $V_{EN1}=V_{IN}, I_{OUT}=10mA$	$\times 0.99$ (*)3	$V_{OUT(T)}^{(*)4}$	$\times 1.01$ (*)3	V	①
		$V_{OUT} \leq 1.95V$ (A, B Series), $V_{EN1}=V_{IN}, I_{OUT}=10mA$	-0.02 (*)3		+0.02 (*)3		
		$V_{OUT(T)} > 1.5V$ (C, D Series) $V_{EN1}=V_{IN}, I_{OUT}=10mA$	$\times 0.98$ (*)3		$\times 1.02$ (*)3		
		$V_{OUT} \leq 1.5V$ (C, D Series) $V_{EN1}=V_{IN}, I_{OUT}=10mA$	-0.03 (*)3		+0.03 (*)3		
Output Current	$I_{OUTMAX}$		300			mA	①
Load Regulation	$\Delta V_{OUT}$	$V_{EN1}=V_{IN}, 0.1mA \leq I_{OUT} \leq 200mA$	Refer to table E-11			mV	①
Dropout Voltage <sup>(*)5</sup>	Vdif	$I_{OUT}=200mA, V_{EN1}=V_{IN}$	Refer to table E-12			mV	①
Supply Current	$I_{SS}$	$V_{IN}=V_{EN1}=V_{OUT(T)}+1.0V, I_{OUT}=0mA$		28	70	$\mu A$	②
Stand-by Current	$I_{STBY}$	$V_{IN}=6.0V, V_{EN1}=V_{SS}$		0.01	0.1	$\mu A$	②
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN} \cdot V_{OUT}}$	$V_{OUT(T)}+0.5V \leq V_{IN} \leq 6.0V$ : $V_{OUT(T)} \geq 1.0V$ $V_{EN1}=V_{IN}, I_{OUT}=10mA$		0.01	0.20	%V	①
		$1.5V \leq V_{IN} \leq 6.0V$ : $V_{OUT(T)} \leq 0.95V$ $V_{EN1}=V_{IN}, I_{OUT}=10mA$					
Input Voltage	$V_{IN}$		1.5		6.0	V	①
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta Ta \cdot V_{OUT}}$	$V_{EN1}=V_{IN}, I_{OUT}=30mA$ $-40^\circ C \leq Ta \leq 85^\circ C$		$\pm 100$		ppm/°C	①
Ripple Rejection Rate	PSRR	$V_{IN} = \{V_{OUT(T)} + 1.0\} V_{DC} + 0.5V_{p-pAC}$ : $V_{OUT(T)} \leq 4.75V$ $V_{EN1}=V_{IN}, I_{OUT}=30mA, f=1kHz$		60		dB	③
		$V_{IN} = 5.75V_{DC} + 0.5V_{p-pAC}$ : $V_{OUT(T)} \geq 4.8V$ $V_{EN1}=V_{IN}, I_{OUT}=30mA, f=1kHz$					
Limit Current	$I_{LIM}$	$V_{EN1}=V_{IN}$	310	400		mA	①
Short Current	$I_{SHORT}$	$V_{EN1}=V_{IN},$ Short $V_{OUT}$ to $V_{SS}$ level		30		mA	①
EN "H" Level Voltage	$V_{ENH}$		1.2		6.0	V	①
EN "L" Level Voltage	$V_{ENL}$				0.3	V	①
EN "H" Level Current	$I_{ENH}$	$V_{EN1}=V_{IN}$	-0.1		0.1	$\mu A$	①
EN "L" Level Current	$I_{ENL}$	$V_{EN1}=V_{SS}$	-0.1		0.1	$\mu A$	①
$C_L$ Discharge Resistor <sup>(*)8</sup>	$R_{DCHG}$	$V_{IN}=6.0V, V_{OUT}=4.0V, V_{EN1}=V_{SS}$		550		$\Omega$	①

**NOTE:**

\*1: Unless otherwise stated,  $V_{IN}=V_{OUT(T)}+1.0V, V_{EN2}=0V$ .

\*2:  $V_{OUT(E)}$  = Actual output voltage (refer to the voltage table)

(ie. The output voltage when " $V_{OUT(T)}+1.0V$ " is provided at the  $V_{IN}$  pin while maintaining a certain  $I_{OUT}$  value.

\*3: Characteristics of the actual  $V_{OUT(E)}$  by nominal output voltage is shown in the voltage table.

\*4:  $V_{OUT(T)}$  is nominal output voltage

\*5:  $V_{dif} = V_{IN1}^{(*)7} - V_{OUT3}^{(*)6}$

\*6:  $V_{OUT3}$  is a voltage equal to 98% of the  $V_{OUT(T)}$  when an amply stabilized input voltage is applied in  $V_{OUT(T)}+1.0V$ .

\*7:  $V_{IN1}$  is the input voltage when  $V_{OUT3}$  appears while input voltage is gradually decreased.

\*8: For XC6419Bx/Dx series only.

XC6419Ax/Cx series discharge with only Rx1 and Rx2 resistors as shown in the BLOCK DIAGRAMS.

## ELECTRICAL CHARACTERISTICS (Continued)

XC6419 Series

Regulator 2

Ta=25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS	CIRCUITS
Output Voltage	$V_{OUT(E)}^{(*)2}$	$V_{OUT(T)} \geq 2.0V$ (A, B Series), $V_{EN2}=V_{IN}$ , $I_{OUT}=10mA$	$\times 0.99$ (*)3	$V_{OUT(T)}^{(*)4}$	$\times 1.01$ (*)3	V	
		$V_{OUT} \leq 1.95V$ (A, B Series), $V_{EN2}=V_{IN}$ , $I_{OUT}=10mA$	-0.02 (*)3		+0.02 (*)3		
		$V_{OUT(T)} > 1.5V$ (C, D Series) $V_{EN2}=V_{IN}$ , $I_{OUT}=10mA$	$\times 0.98$ (*)3		$\times 1.02$ (*)3		
		$V_{OUT} \leq 1.5V$ (C, D Series) $V_{EN2}=V_{IN}$ , $I_{OUT}=10mA$	-0.03 (*)3		+0.03 (*)3		
Output Current	$I_{OUTMAX}$		100			mA	
Load Regulation	$\Delta V_{OUT}$	$V_{EN2}=V_{IN}$ , $0.1mA \leq I_{OUT} \leq 50mA$	Refer to table E-21			mV	
Dropout Voltage <sup>(*)5</sup>	Vdif	$I_{OUT}=50mA$ , $V_{EN2}=V_{IN}$	Refer to table E-22			mV	
Supply Current	$I_{SS}$	$V_{IN}=V_{EN2}=V_{OUT(T)}+1.0V$ , $I_{OUT}=0mA$		23	60	$\mu A$	
Stand-by Current	$I_{STBY}$	$V_{IN}=6.0V$ , $V_{EN2}=V_{SS}$		0.01	0.1	$\mu A$	
Line Regulation	$\frac{\Delta V_{OUT}}{\Delta V_{IN}} \cdot V_{OUT}$	$V_{OUT(T)}+0.5V \leq V_{IN} \leq 6.0V$ : $V_{OUT(T)} \geq 1.0V$ $V_{EN2}=V_{IN}$ , $I_{OUT}=10mA$		0.01	0.20	%V	
		$1.5V \leq V_{IN} \leq 6.0V$ : $V_{OUT(T)} \leq 0.95V$ $V_{EN2}=V_{IN}$ , $I_{OUT}=10mA$					
Input Voltage	$V_{IN}$		1.5		6.0	V	
Output Voltage Temperature Characteristics	$\frac{\Delta V_{OUT}}{\Delta Ta} \cdot V_{OUT}$	$V_{EN2}=V_{IN}$ , $I_{OUT}=30mA$ $-40^\circ C \leq Ta \leq 85^\circ C$		$\pm 100$		ppm/	
Ripple Rejection Rate	PSRR	$V_{IN}=\{V_{OUT(T)}+1.0\}$ $V_{DC}+0.5Vp-pAC$ : $V_{OUT(T)} \leq 4.75V$ $V_{EN2}=V_{IN}$ , $I_{OUT}=30mA$ , $f=1kHz$		60		dB	
		$V_{IN}=5.75V_{DC}+0.5Vp-pAC$ : $V_{OUT(T)} \geq 4.8V$ $V_{EN2}=V_{IN}$ , $I_{OUT}=30mA$ , $f=1kHz$					
Limit Current	$I_{LIM}$	$V_{EN2}=V_{IN}$	110	150		mA	
Short Current	$I_{SHORT}$	$V_{EN2}=V_{IN}$ , Short $V_{OUT}$ to $V_{SS}$ level		15		mA	
EN "H" Level Voltage	$V_{ENH}$		1.2		6.0	V	
EN "L" Level Voltage	$V_{ENL}$				0.3	V	
EN "H" Level Current	$I_{ENH}$	$V_{EN2}=V_{IN}$	-0.1		0.1	$\mu A$	
EN "L" Level Current	$I_{ENL}$	$V_{EN2}=V_{SS}$	-0.1		0.1	$\mu A$	
$C_L$ Discharge Resistor <sup>(*)8</sup>	$R_{DCHG}$	$V_{IN}=6.0V$ , $V_{OUT}=4.0V$ , $V_{EN2}=V_{SS}$		550		$\Omega$	

**NOTE:**

\*1: Unless otherwise stated,  $V_{IN}=V_{OUT(T)}+1.0V$ ,  $V_{EN1}=0V$ .

\*2:  $V_{OUT(E)}$  is actual output voltage (refer to the voltage table)

(ie. The output voltage when " $V_{OUT(T)}+1.0V$ " is provided at the  $V_{IN}$  pin while maintaining a certain  $I_{OUT}$  value.

\*3: Characteristics of the actual  $V_{OUT(E)}$  by nominal output voltage is shown in the voltage table

\*4:  $V_{OUT(T)}$  is nominal output voltage

\*5:  $V_{dif} = V_{IN1}^{(*)7} - V_{OUT3}^{(*)6}$

\*6:  $V_{OUT3}$  is a voltage equal to 98% of the output voltage whenever an amply stabilized  $I_{OUT}\{V_{OUT(T)}+1.0V\}$  is input.

\*7:  $V_{IN1}$  is the input voltage when  $V_{OUT3}$  appears while input voltage is gradually decreased.

\*8: For XC6419 xB/xD series only.

XC6419 xA/xC series discharge with only Rx1 and Rx2 resistors as shown in the BLOCK DIAGRAMS.

## ELECTRICAL CHARACTERISTICS

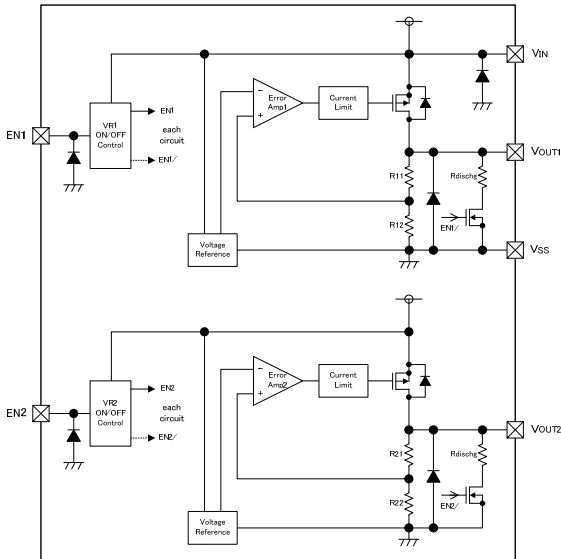
NOMINAL OUTPUT VOLTAGE (V)	OUTPUT VOLTAGE $\pm 1\%$ (A, B Series) (V)		OUTPUT VOLTAGE $\pm 2\%$ (C, D Series) (V)		REGULATOR 1				REGULATOR 2			
					LOAD REGULATION E-11 (mV)		DROPOUT VOLTAGE E-12 (mV)		LOAD REGULATION E-21 (mV)		DROPOUT VOLTAGE E-22 (mV)	
	$V_{OUT(T)}$		$V_{OUT(E)}$		$\Delta V_{OUT}$		$V_{dif}$		$\Delta V_{OUT}$		$V_{dif}$	
	MIN	MAX	MIN	MAX	TYP	MAX	TYP	MAX	TYP	MAX	TYP	MAX
0.80	0.7800	0.8200	0.7700	0.8300	15	25	580	750	15	20	590	800
0.85	0.8300	0.8700	0.8200	0.8800	15	25	580	750	15	20	590	800
0.90	0.8800	0.9200	0.8700	0.9300	15	25	540	700	15	20	540	750
0.95	0.9300	0.9700	0.9200	0.9800	15	25	540	700	15	20	540	700
1.00	0.9800	1.0200	0.9700	1.0300	15	25	480	650	15	20	480	650
1.05	1.0300	1.0700	1.0200	1.0800	15	25	480	640	15	20	480	650
1.10	1.0800	1.1200	1.0700	1.1300	15	25	440	610	15	20	420	600
1.15	1.1300	1.1700	1.1200	1.1800	15	25	440	580	15	20	420	600
1.20	1.1800	1.2200	1.1700	1.2300	15	25	380	540	15	20	350	550
1.25	1.2300	1.2700	1.2200	1.2800	15	25	380	520	15	20	350	550
1.30	1.2800	1.3200	1.2700	1.3300	15	30	330	450	15	25	300	480
1.35	1.3300	1.3700	1.3200	1.3800	15	30	330	450	15	25	300	480
1.40	1.3800	1.4200	1.3700	1.4300	15	30	280	410	15	25	280	430
1.45	1.4300	1.4700	1.4200	1.4800	15	30	280	350	15	25	250	380
1.50	1.4800	1.5200	1.4700	1.5300	15	30	220	290	15	25	220	330
1.55	1.5300	1.5700	1.5190	1.5810	15	30	220	290	15	25	220	330
1.60	1.5800	1.6200	1.5680	1.6320	15	30	220	290	15	25	220	330
1.65	1.6300	1.6700	1.6170	1.6830	15	30	200	270	15	25	200	310
1.70	1.6800	1.7200	1.6660	1.7340	15	30	200	270	15	25	200	310
1.75	1.7300	1.7700	1.7150	1.7850	15	30	190	250	15	25	190	280
1.80	1.7800	1.8200	1.7640	1.8360	15	30	190	250	15	25	190	280
1.85	1.8300	1.8700	1.8130	1.8870	15	30	190	250	15	25	190	280
1.90	1.8800	1.9200	1.8620	1.9380	15	30	190	250	15	25	190	280
1.95	1.9300	1.9700	1.9110	1.9890	15	30	170	230	15	25	170	260
2.00	1.9800	2.0200	1.9600	2.0400	20	40	170	230	15	25	170	260
2.05	2.0295	2.0705	2.0090	2.0910	20	40	170	230	15	30	170	260
2.10	2.0790	2.1210	2.0580	2.1420	20	40	150	210	15	30	150	240
2.15	2.1285	2.1715	2.1070	2.1930	20	40	150	210	15	30	150	240
2.20	2.1780	2.2220	2.1560	2.2440	20	40	150	210	15	30	150	240
2.25	2.2275	2.2725	2.2050	2.2950	20	40	150	210	15	30	150	240
2.30	2.2770	2.3230	2.2540	2.3460	20	40	140	190	15	30	140	220
2.35	2.3265	2.3735	2.3030	2.3970	20	40	140	190	15	30	140	220
2.40	2.3760	2.4240	2.3520	2.4480	20	40	140	190	15	30	140	220
2.45	2.4255	2.4745	2.4010	2.4990	20	40	140	190	15	30	140	220
2.50	2.4750	2.5250	2.4500	2.5500	20	40	140	190	15	30	140	220
2.55	2.5245	2.5755	2.4990	2.6010	20	40	140	190	15	30	140	220
2.60	2.5740	2.6260	2.5480	2.6520	20	40	125	170	15	30	125	200
2.65	2.6235	2.6765	2.5970	2.7030	20	40	125	170	15	30	125	200
2.70	2.6730	2.7270	2.6460	2.7540	20	40	125	170	15	30	125	200
2.75	2.7225	2.7775	2.6950	2.8050	20	40	125	170	15	30	125	200
2.80	2.7720	2.8280	2.7440	2.8560	20	40	115	150	15	30	115	180
2.85	2.8215	2.8785	2.7930	2.9070	20	40	115	150	15	30	115	180
2.90	2.8710	2.9290	2.8420	2.9580	20	40	115	150	15	30	115	180
2.95	2.9205	2.9795	2.8910	3.0090	20	40	115	150	15	30	115	180

## ELECTRICAL CHARACTERISTICS (Continued)

NOMINAL OUTPUT VOLTAGE (V)	OUTPUT VOLTAGE ±1% (A, B Series) (V)		OUTPUT VOLTAGE ±2% (C, D Series) (V)		REGULATOR 1				REGULATOR 2			
					LOAD REGULATION E-11 (mV)		DROPOUT VOLTAGE E-12 (mV)		LOAD REGULATION E-21 (mV)		DROPOUT VOLTAGE E-22 (mV)	
	$V_{OUT(T)}$		$V_{OUT(E)}$		$\Delta V_{OUT}$		$V_{dif}$		$\Delta V_{OUT}$		$V_{dif}$	
	MIN	MAX	MIN	MAX	TYP	MAX	TYP	MAX	TYP	MAX	TYP	MAX
3.00	2.9700	3.0300	2.9400	3.0600	25	50	115	150	20	40	115	180
3.05	3.0195	3.0805	2.9890	3.1110	25	50	115	150	20	40	115	180
3.10	3.0690	3.1310	3.0380	3.1620	25	50	115	150	20	40	115	180
3.15	3.1185	3.1815	3.0870	3.2130	25	50	115	150	20	40	115	180
3.20	3.1680	3.2320	3.1360	3.2640	25	50	115	150	20	40	115	180
3.25	3.2175	3.2825	3.1850	3.3150	25	50	115	150	20	40	115	180
3.30	3.2670	3.3330	3.2340	3.3660	25	50	115	150	20	40	115	180
3.35	3.3165	3.3835	3.2830	3.4170	25	50	115	150	20	40	115	180
3.40	3.3660	3.4340	3.3320	3.4680	25	50	115	150	20	40	115	180
3.45	3.4155	3.4845	3.3810	3.5190	25	50	115	150	20	40	115	180
3.50	3.4650	3.5350	3.4300	3.5700	25	50	100	135	20	40	100	170
3.55	3.5145	3.5855	3.4790	3.6210	25	50	100	135	20	40	100	170
3.60	3.5640	3.6360	3.5280	3.6720	25	50	100	135	20	40	100	170
3.65	3.6135	3.6865	3.5770	3.7230	25	50	100	135	20	40	100	170
3.70	3.6630	3.7370	3.6260	3.7740	25	50	100	135	20	40	100	170
3.75	3.7125	3.7875	3.6750	3.8250	25	50	100	135	20	40	100	170
3.80	3.7620	3.8380	3.7240	3.8760	25	50	100	135	20	40	100	170
3.85	3.8115	3.8885	3.7730	3.9270	25	50	100	135	20	40	100	170
3.90	3.8610	3.9390	3.8220	3.9780	25	50	100	135	20	40	100	170
3.95	3.9105	3.9895	3.8710	4.0290	25	50	100	135	20	40	100	170
4.00	3.9600	4.0400	3.9200	4.0800	25	50	95	125	20	40	95	165
4.05	4.0095	4.0905	3.9690	4.1310	25	50	95	125	20	40	95	165
4.10	4.0590	4.1410	4.0180	4.1820	25	50	95	125	20	40	95	165
4.15	4.1085	4.1915	4.0670	4.2330	25	50	95	125	20	40	95	165
4.20	4.1580	4.2420	4.1160	4.2840	25	50	95	125	20	40	95	165
4.25	4.2075	4.2925	4.1650	4.3350	25	50	95	125	20	40	95	165
4.30	4.2570	4.3430	4.2140	4.3860	25	50	95	125	20	40	95	165
4.35	4.3065	4.3935	4.2630	4.4370	25	50	95	125	20	40	95	165
4.40	4.3560	4.4440	4.3120	4.4880	25	50	95	125	20	40	95	165
4.45	4.4055	4.4945	4.3610	4.5390	25	50	95	125	20	40	95	165
4.50	4.4550	4.5450	4.4100	4.5900	25	50	95	125	20	40	95	165
4.55	4.5045	4.5955	4.4590	4.6410	25	50	95	125	20	40	95	165
4.60	4.5540	4.6460	4.5080	4.6920	25	50	95	125	20	40	95	165
4.65	4.6035	4.6965	4.5570	4.7430	25	50	95	125	20	40	95	165
4.70	4.6530	4.7470	4.6060	4.7940	25	50	95	125	20	40	95	165
4.75	4.7025	4.7975	4.6550	4.8450	25	50	95	125	20	40	95	165
4.80	4.7520	4.8480	4.7040	4.8960	25	50	83	115	20	40	80	155
4.85	4.8015	4.8985	4.7530	4.9470	25	50	83	115	20	40	80	155
4.90	4.8510	4.9490	4.8020	4.9980	25	50	83	115	20	40	80	155
4.95	4.9005	4.9995	4.8510	5.0490	25	50	83	115	20	40	80	155
5.00	4.9500	5.0500	4.9000	5.1000	25	50	83	115	20	40	80	155

## OPERATIONAL DESCRIPTION

The voltage divided by resistors Rx1 and Rx2 is compared with the internal reference voltage by the error amplifier. The P-channel MOSFET connected to the V<sub>OUT</sub> pin is then driven by the subsequent output signal. The output voltage at the V<sub>OUT</sub> pin is controlled and stabilized by a system of negative feedback. The current limit circuit and short protect circuit operate in relation to the level of output current. Further, the IC's internal circuitry can be shutdown via the EN pin's signal.



### <CL Auto-Discharge Function>

XC6419xB/Bx/xD/Dx series can quickly discharge the electric charge at the output capacitor (CL) through the N-channel transistor located between the V<sub>OUT</sub> pin and the V<sub>SS</sub> pin (refer to the BLOCK DIAGRAM) when a low level signal is applied to the EN pin. The C<sub>L</sub> discharge resistance is set to 550 Ω when V<sub>IN</sub> is 6.0V (TYP.) and V<sub>OUT</sub> is 4.0V (TYP.). Moreover, discharge time of the output capacitor (CL) is set by the C<sub>L</sub> auto-discharge resistance (R) and the output capacitor (CL). By setting time constant of a C<sub>L</sub> auto-discharge resistance value [R] and an output capacitor value (CL) as  $\tau = C \times R$ , the output voltage after discharge via the N channel transistor is calculated by the following formulae.

$$V = V_{OUT} \times e^{-t/\tau}, \text{ or } t = \tau \ln(V_{OUT}(E) / V)$$

where

V: Output voltage after discharge, V<sub>OUT</sub> (E): Output voltage, t: Discharge time,  
 τ: CL auto-discharge resistance R<sub>DCHG</sub> × CL capacitance C

C<sub>L</sub> high-speed discharge function can be set by each regulator.

### <Current Limiter, Short-Circuit Protection>

The XC6419 series includes a fold-back circuit, which aid the operations of the current limiter and circuit protection. When the load current reaches the current limit level, the fold-back circuit operates and output voltage drops. As a result of this drop in output voltage, output current also decreases. When the output pin is shorted, the output current flows go down to 30mA/ch1 and 15mA/ch2 (TYP.).

### <EN Pin>

Each regulator can be shut-down via the signal from the EN pin with the XC6419 series. In shutdown mode, output at the V<sub>OUT</sub> pin will be pulled down to the V<sub>SS</sub> level via Rx1 & Rx2. However, as for the XC6419xB/Bx/xD/Dx series, the C<sub>L</sub> auto-discharge resistor is connected in parallel to Rx1 and Rx2 while the power supply is applied to the V<sub>IN</sub> pin. Therefore, time until the V<sub>OUT</sub> pin reaches the V<sub>SS</sub> level becomes short. The output voltage becomes unstable, when the EN pin is open. If this IC is used with the correct output voltage for the EN pin, the logic is fixed and the IC will operate normally. However, supply current may increase as a result of through current in the IC's internal circuitry when medium



## OPERATIONAL DESCRIPTION (Continued)

### <Input and Output Capacitor>

The XC6419 needs an output capacitor  $C_L$  for phase compensation. The requested capacitance values are described in the table below. The device may go into unstable operation when the output capacitance reduction happens as a result of bias or temperature drift. Please choose a capacitor with less influence from temperature and bias. Also, please place 1.0  $\mu$ F input capacitor  $C_{IN}$  between  $V_{IN}$  and  $V_{SS}$  pins for stabilizing input supply voltage.

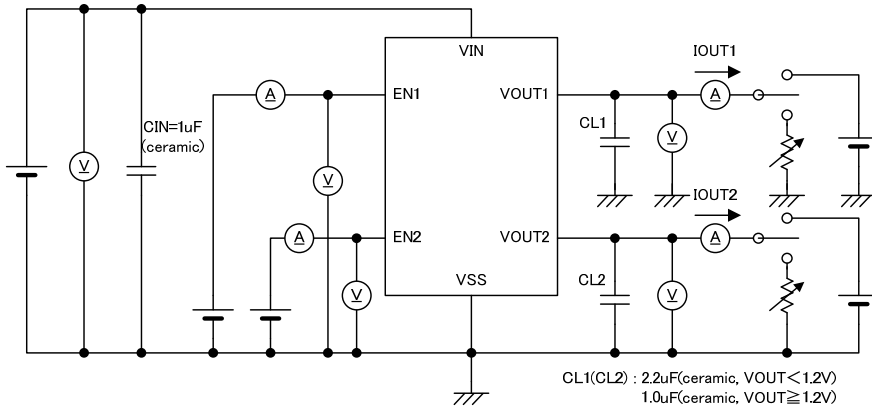
SETTING VOLTAGE	OUTPUT CAPACITOR
0.8V ~ 1.15V	$C_L$ 2.2 $\mu$ F
1.2V ~ 5.0V	$C_L$ 1.0 $\mu$ F

## NOTES ON USE

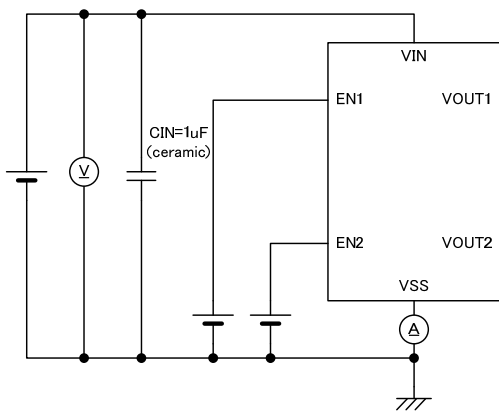
1. Please use this IC within the stated absolute maximum ratings. The IC is liable to malfunction should the ratings be exceeded.
2. Where wiring impedance is high, operations may become unstable due to noise and/or phase lag depending on output current. Please wire the input capacitor  $C_{IN}$  and the output capacitor  $C_L$  as close to the IC as possible.

## TEST CIRCUITS

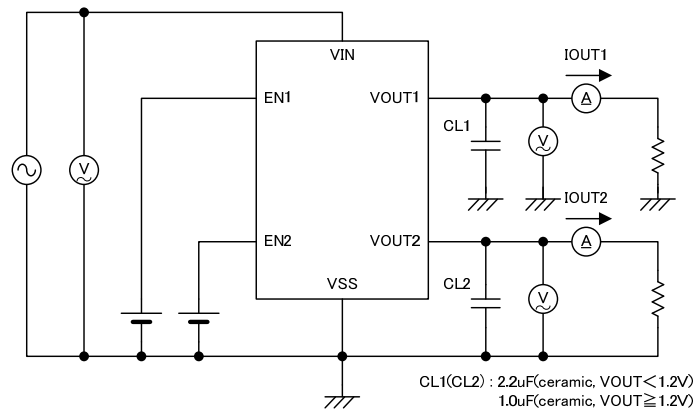
Circuit



Circuit



Circuit

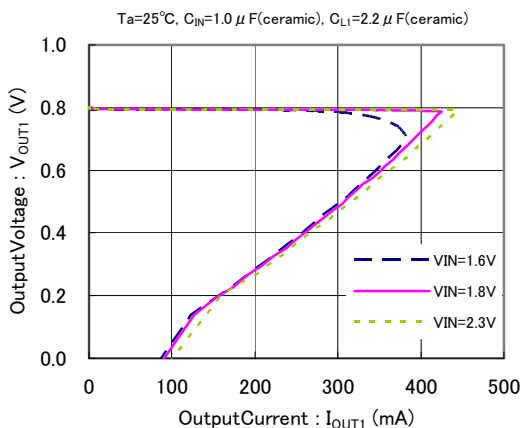


## TYPICAL PERFORMANCE CHARACTERISTICS

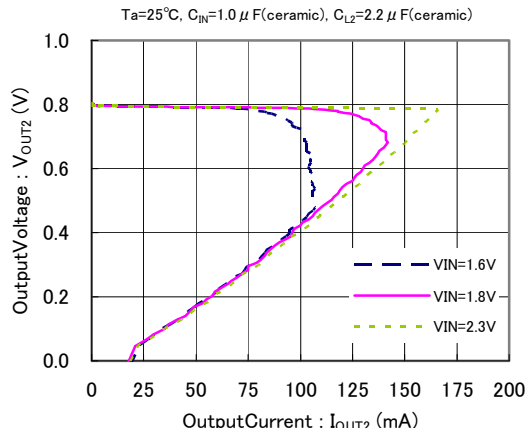
\* EN Voltage condition: Unless otherwise stated,  $V_{EN}=V_{IN}$  while the other channel is turned off ( $V_{EN}=V_{SS}$ ).

### (1) Output Voltage vs. Output Current

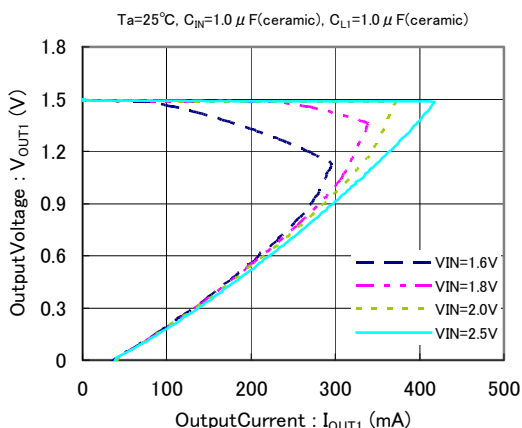
XC6419( $V_{OUT1}=0.8V$ ) VR1



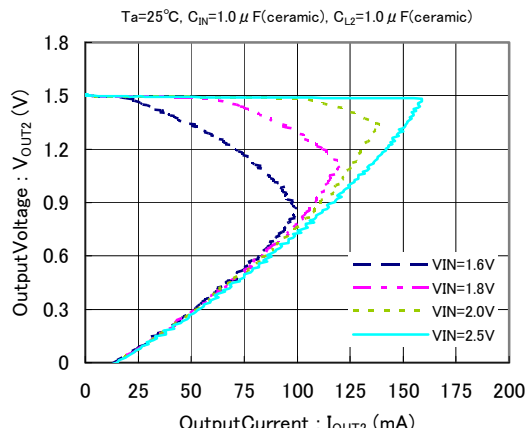
XC6419( $V_{OUT2}=0.8V$ ) VR2



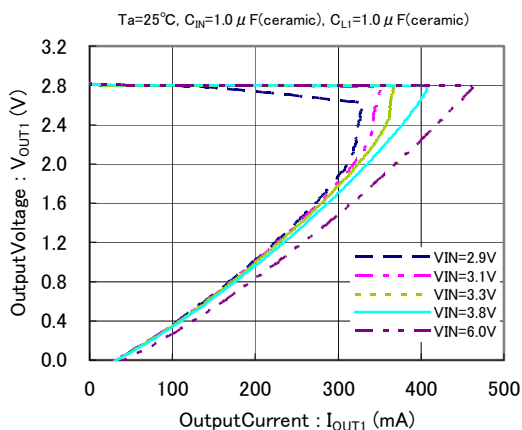
XC6419( $V_{OUT1}=1.5V$ ) VR1



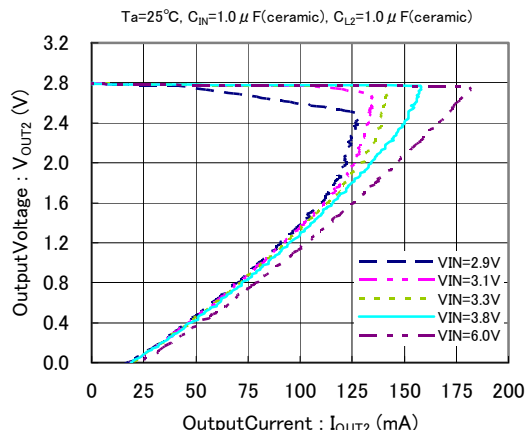
XC6419( $V_{OUT2}=1.5V$ ) VR2



XC6419( $V_{OUT1}=2.8V$ ) VR1



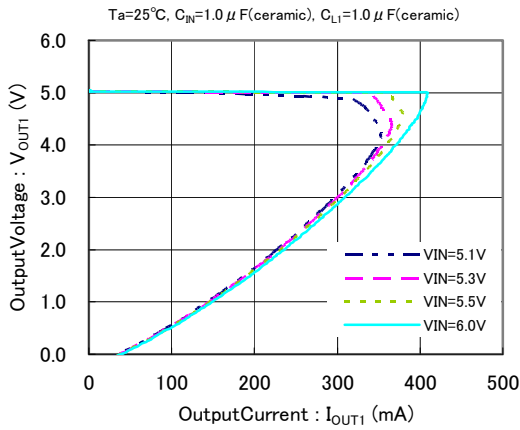
XC6419( $V_{OUT2}=2.8V$ ) VR2



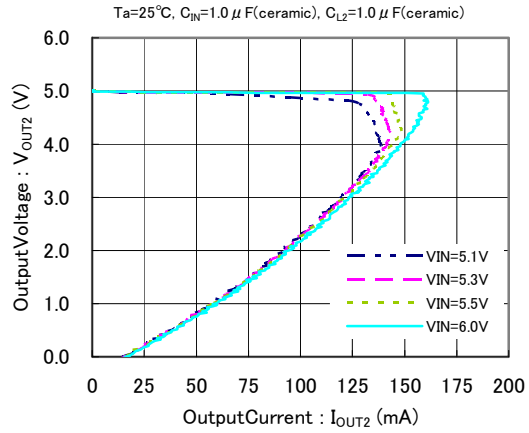
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (1) Output Voltage vs. Output Current (Continued)

XC6419( $V_{OUT1}=5.0V$ ) VR1

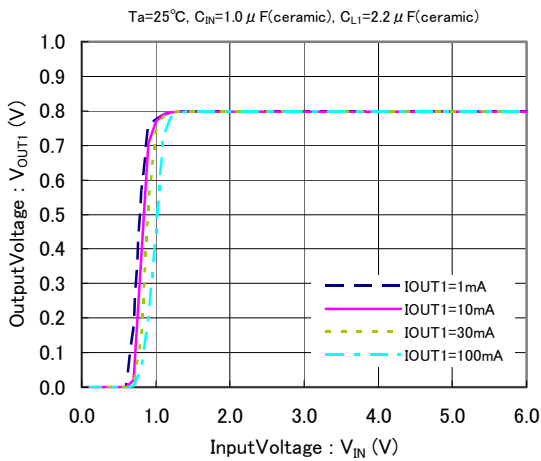


XC6419( $V_{OUT2}=5.0V$ ) VR2

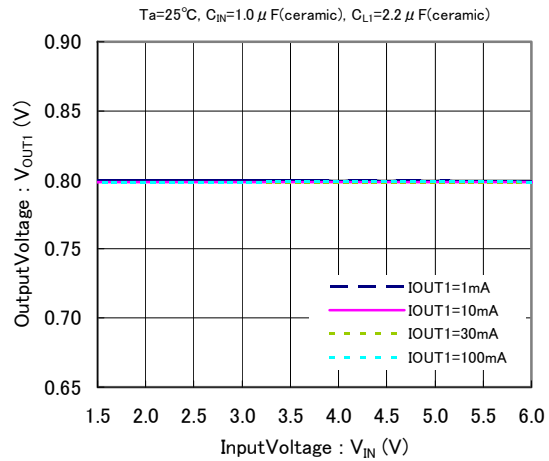


### (2) Output Voltage vs. Input Current

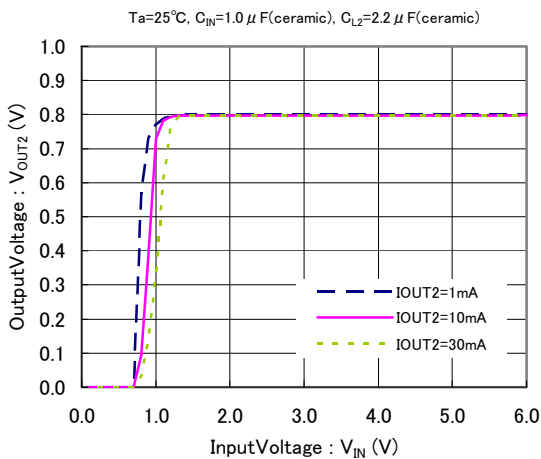
XC6419( $V_{OUT1}=0.8V$ ) VR1



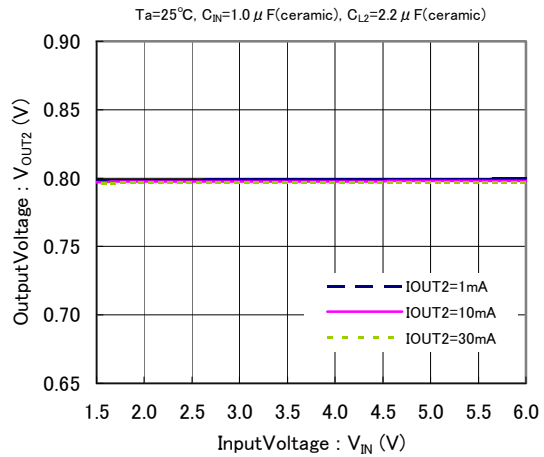
XC6419( $V_{OUT1}=0.8V$ ) VR1



XC6419( $V_{OUT2}=0.8V$ ) VR2



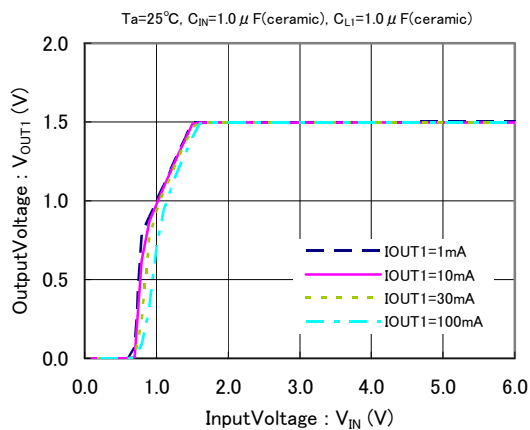
XC6419( $V_{OUT2}=0.8V$ ) VR2



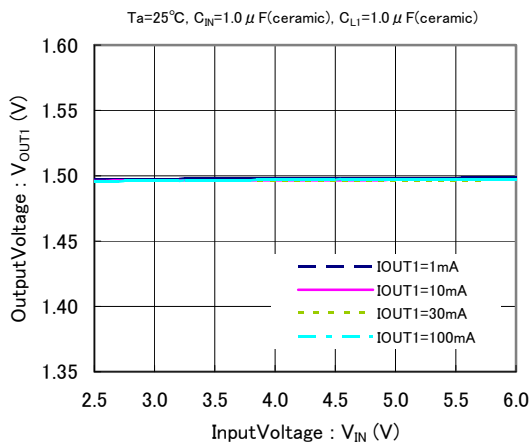
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (2) Output Voltage vs. Input Current (Continued)

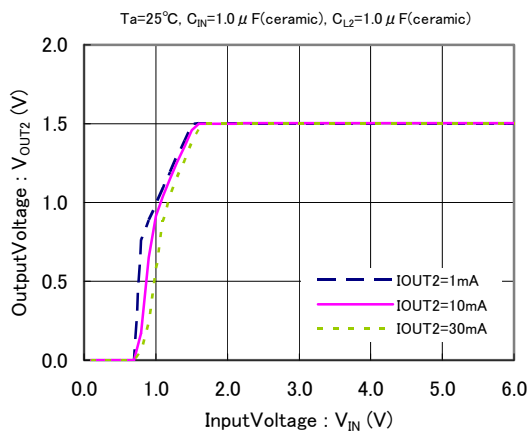
XC6419( $V_{OUT1}=1.5V$ ) VR1



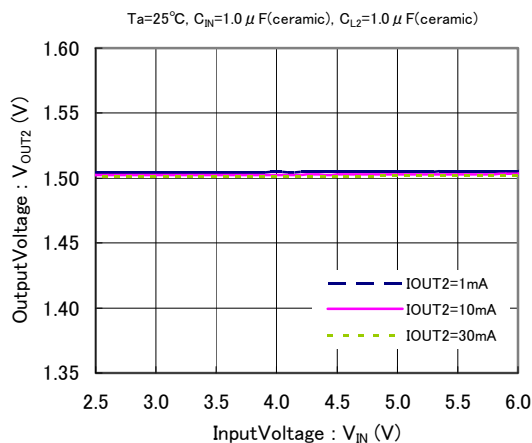
XC6419( $V_{OUT1}=1.5V$ ) VR1



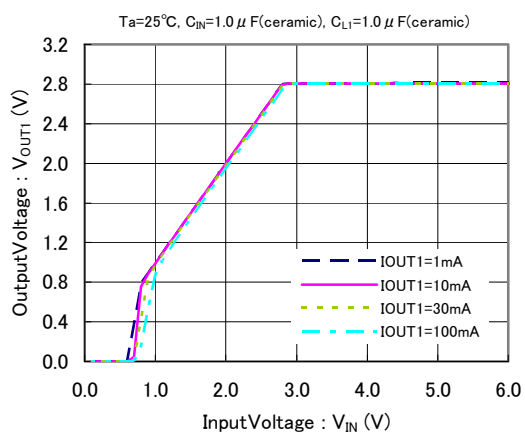
XC6419( $V_{OUT2}=1.5V$ ) VR2



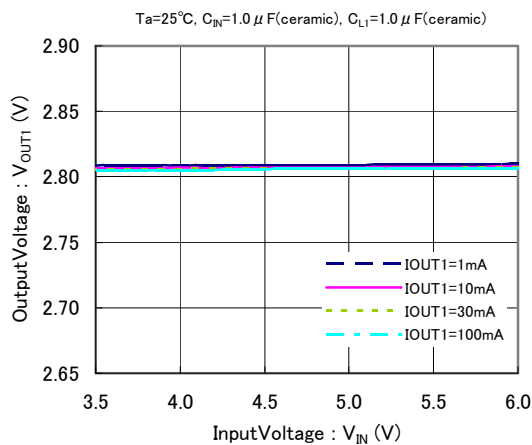
XC6419( $V_{OUT2}=1.5V$ ) VR2



XC6419( $V_{OUT1}=2.8V$ ) VR1



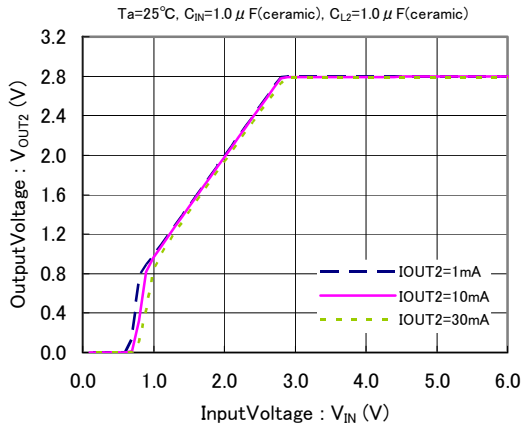
XC6419( $V_{OUT1}=2.8V$ ) VR1



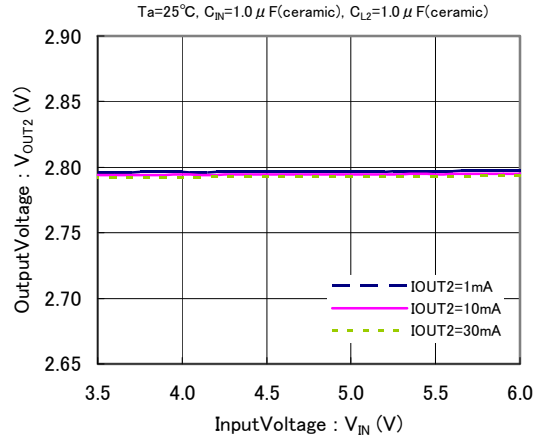
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (2) Output Voltage vs. Input Current (Continued)

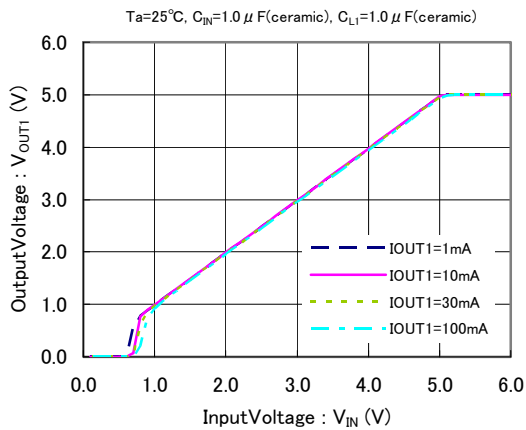
XC6419( $V_{OUT2}=2.8V$ ) VR2



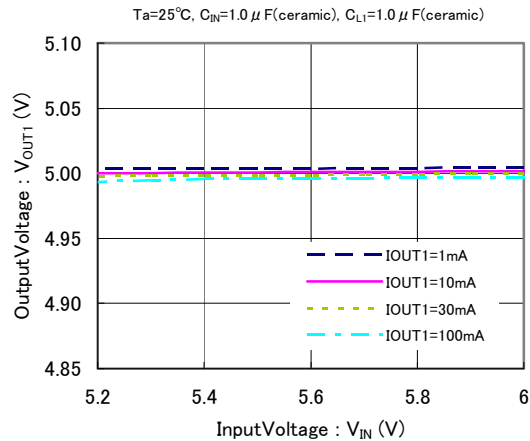
XC6419( $V_{OUT2}=2.8V$ ) VR2



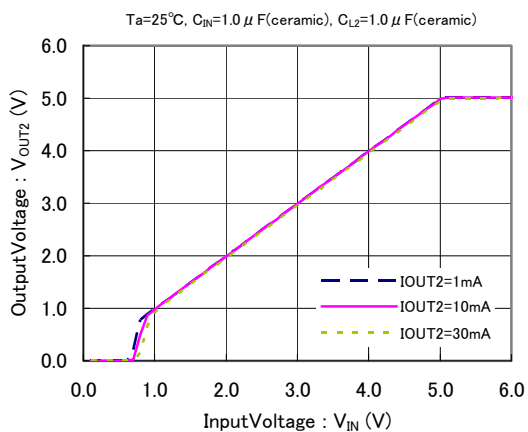
XC6419( $V_{OUT1}=5.0V$ ) VR1



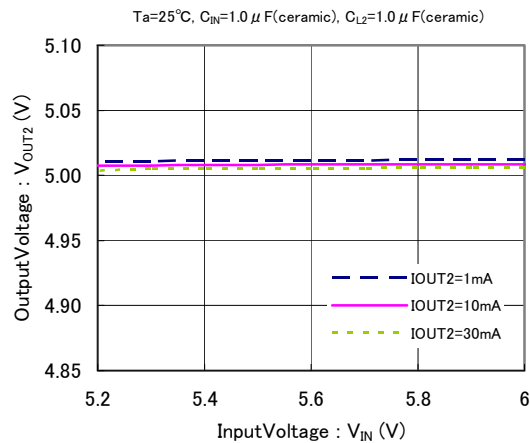
XC6419( $V_{OUT1}=5.0V$ ) VR1



XC6419( $V_{OUT2}=5.0V$ ) VR2



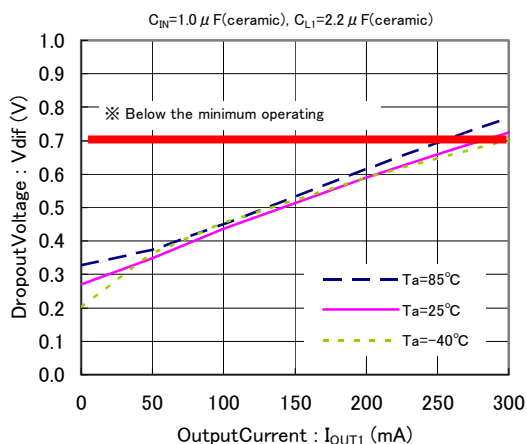
XC6419( $V_{OUT2}=5.0V$ ) VR2



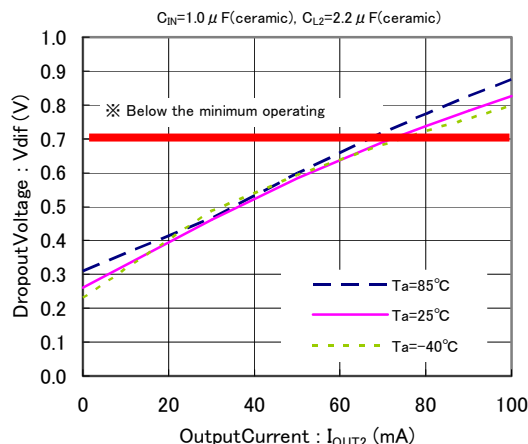
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (3) Dropout Voltage vs. Output Current

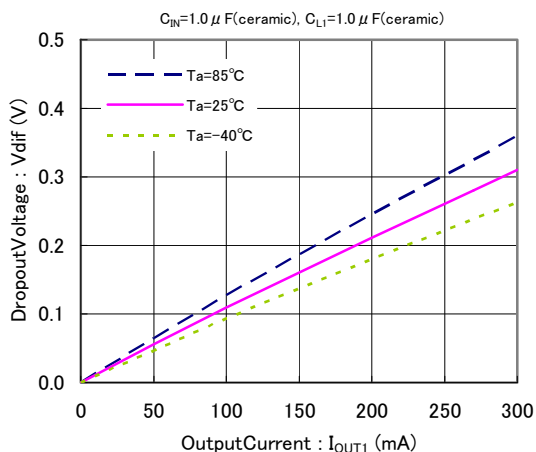
XC6419( $V_{OUT1}=0.8V$ ) VR1



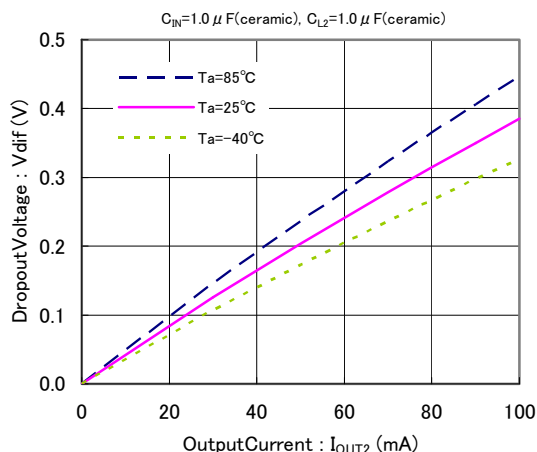
XC6419( $V_{OUT2}=0.8V$ ) VR2



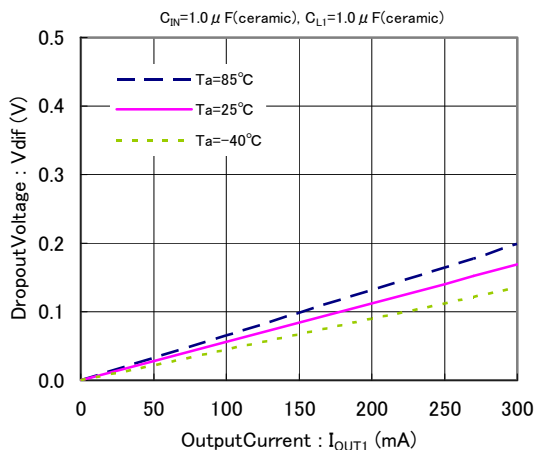
XC6419( $V_{OUT1}=1.5V$ ) VR1



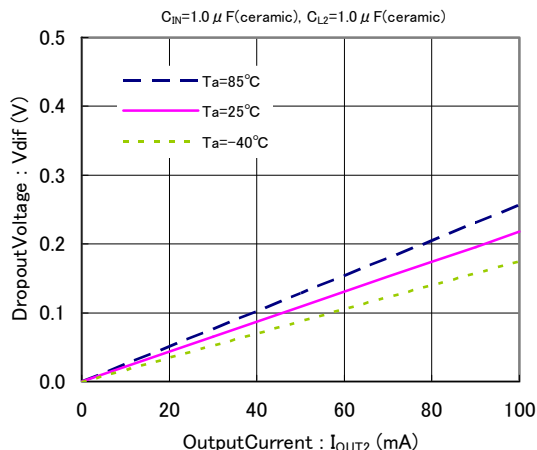
XC6419( $V_{OUT2}=1.5V$ ) VR2



XC6419( $V_{OUT1}=2.8V$ ) VR1



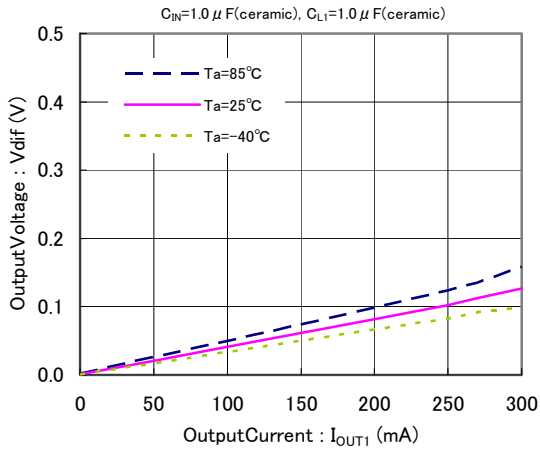
XC6419( $V_{OUT2}=2.8V$ ) VR2



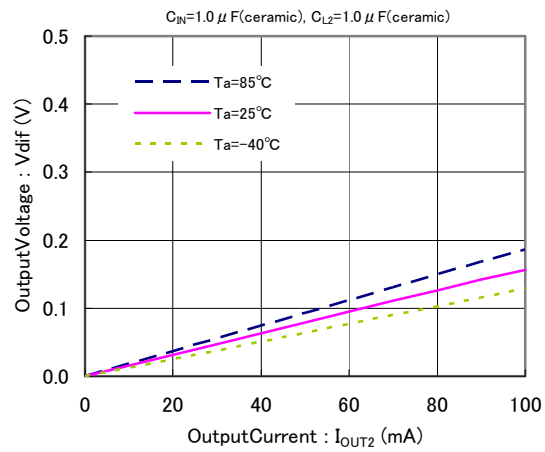
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (3) Dropout Voltage vs. Output Current

XC6419( $V_{OUT1}=5.0V$ ) VR1

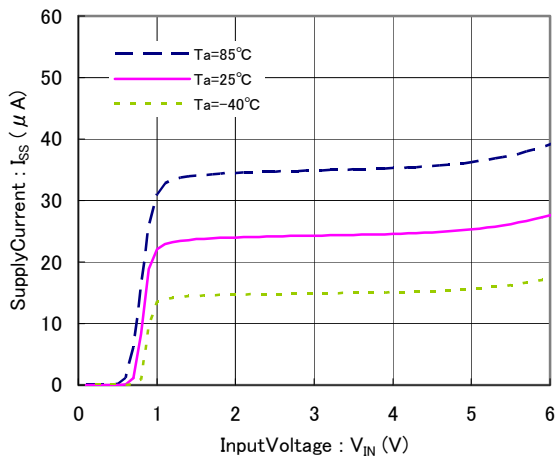


XC6419( $V_{OUT2}=5.0V$ ) VR2

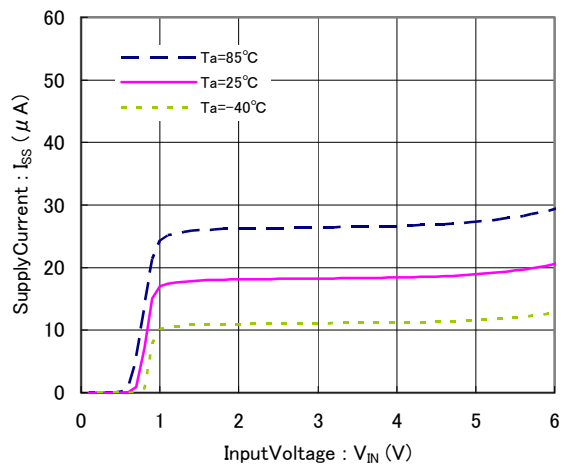


### (4) Supply Current vs. Input Voltage

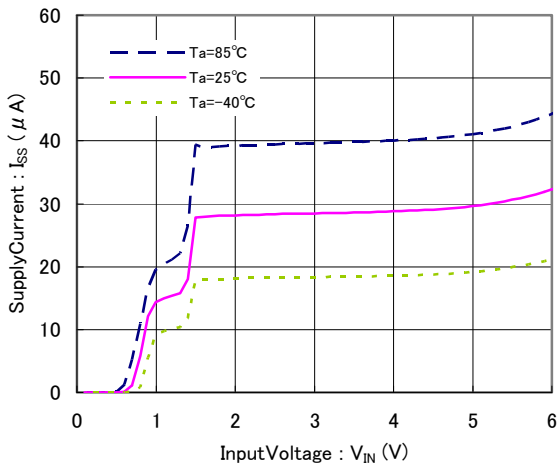
XC6419( $V_{OUT1}=0.8V$ ) VR1



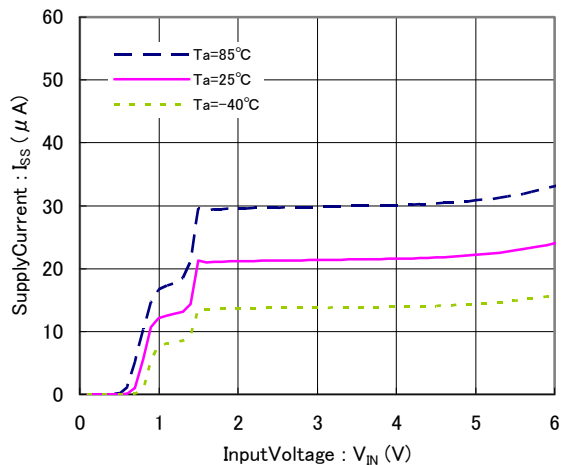
XC6419( $V_{OUT2}=0.8V$ ) VR2



XC6419( $V_{OUT1}=1.5V$ ) VR1



XC6419( $V_{OUT2}=1.5V$ ) VR2

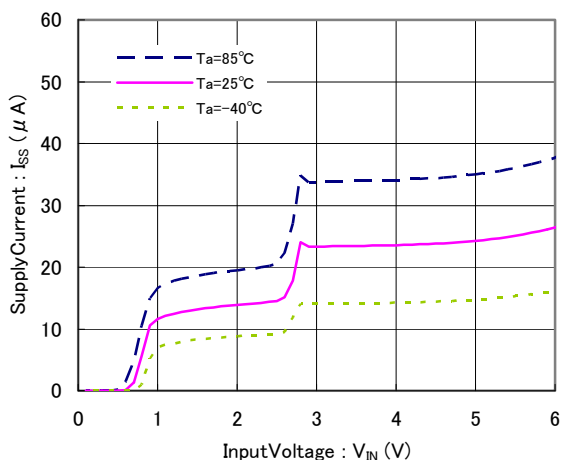




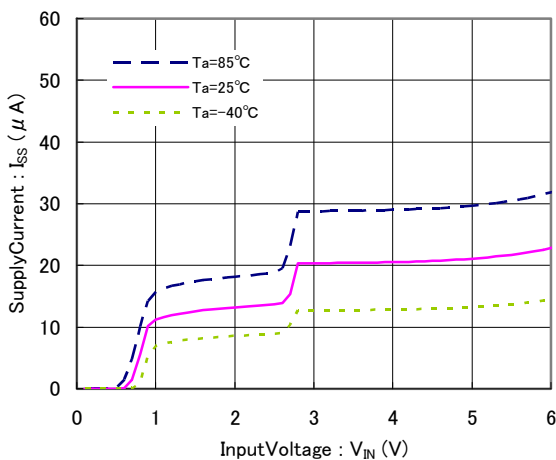
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (4) Supply Current vs. Input Voltage (Continued)

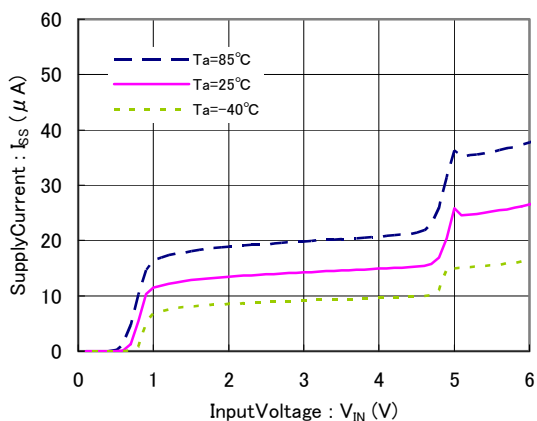
XC6419( $V_{OUT1}=2.8V$ ) VR1



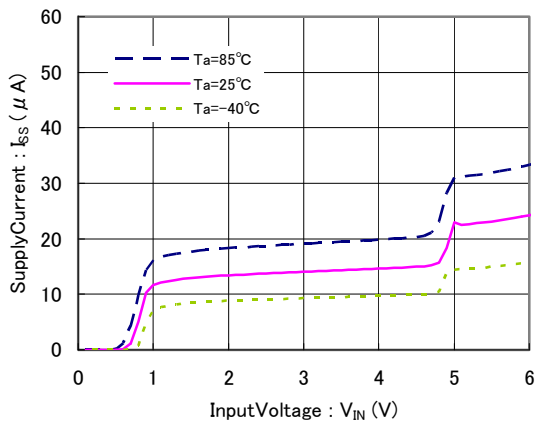
XC6419( $V_{OUT2}=2.8V$ ) VR2



XC6419( $V_{OUT1}=5.0V$ ) VR1

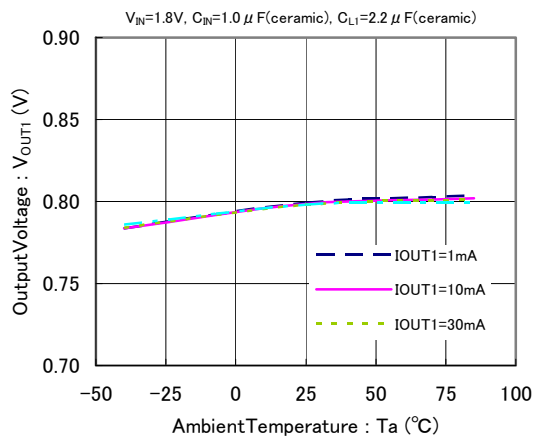


XC6419( $V_{OUT2}=5.0V$ ) VR2

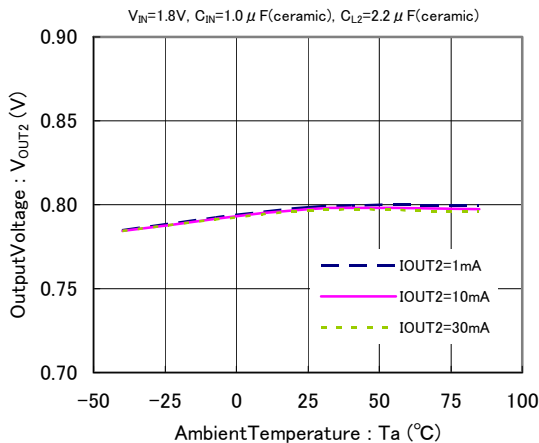


### (5) Output Voltage vs. Ambient Temperature

XC6419( $V_{OUT1}=0.8V$ ) VR1



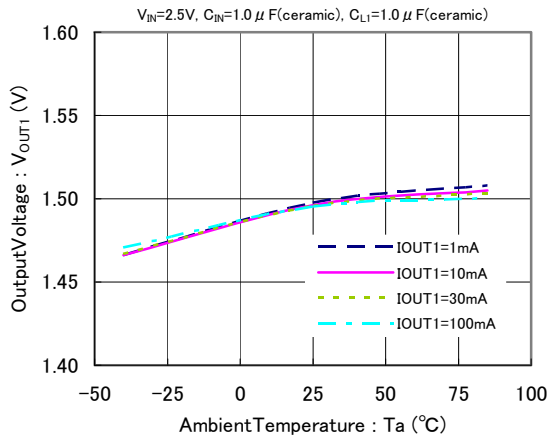
XC6419( $V_{OUT2}=0.8V$ ) VR2



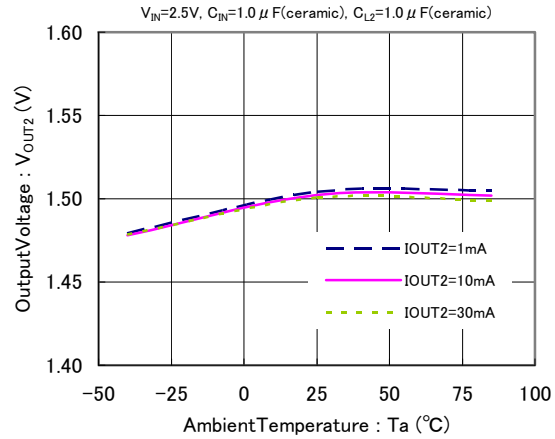
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (5) Output Voltage vs. Ambient Temperature (Continued)

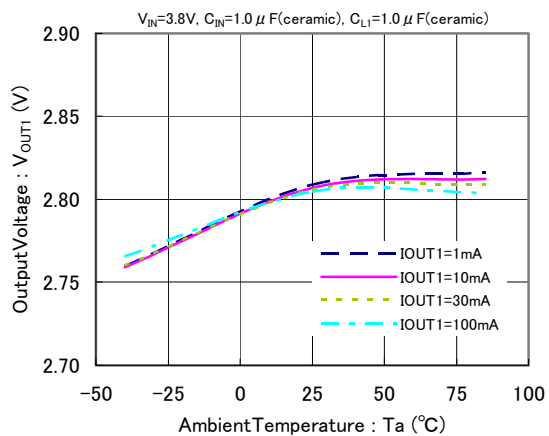
XC6419( $V_{OUT1}=1.5V$ ) VR1



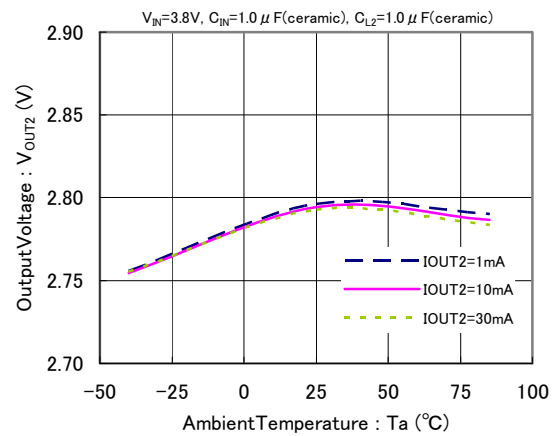
XC6419( $V_{OUT2}=1.5V$ ) VR2



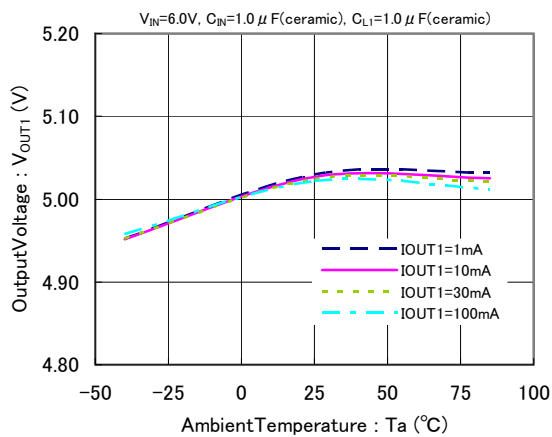
XC6419( $V_{OUT1}=2.8V$ ) VR1



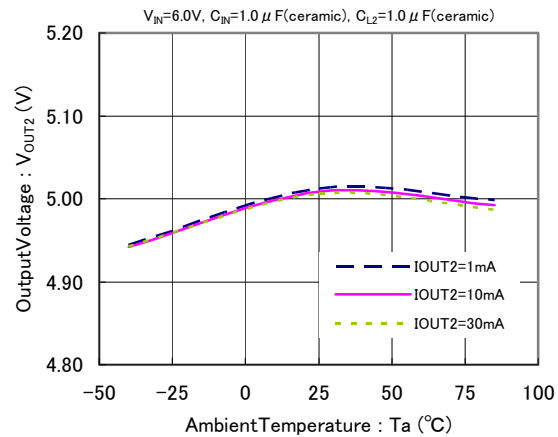
XC6419( $V_{OUT2}=2.8V$ ) VR2



XC6419( $V_{OUT1}=5.0V$ ) VR1



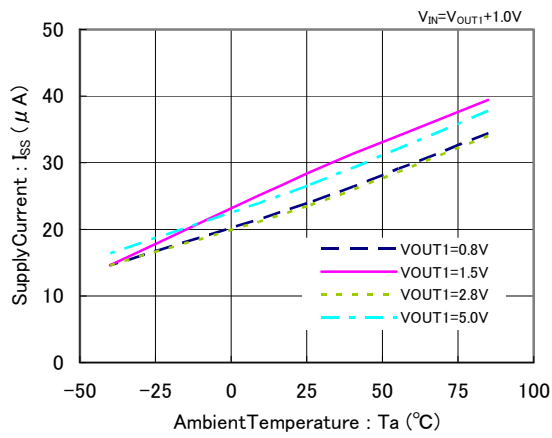
XC6419( $V_{OUT2}=5.0V$ ) VR2



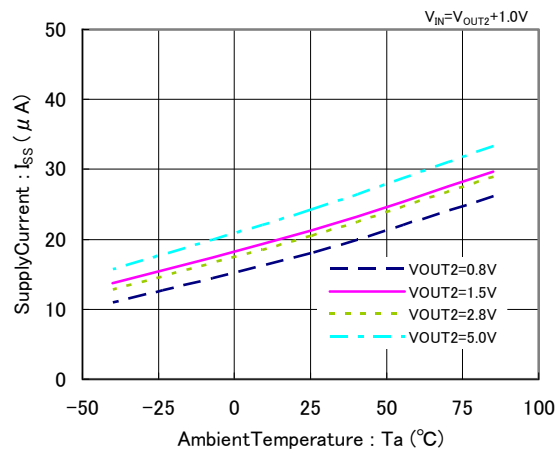
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

(6) Supply Current vs. Ambient Temperature

XC6419 VR1

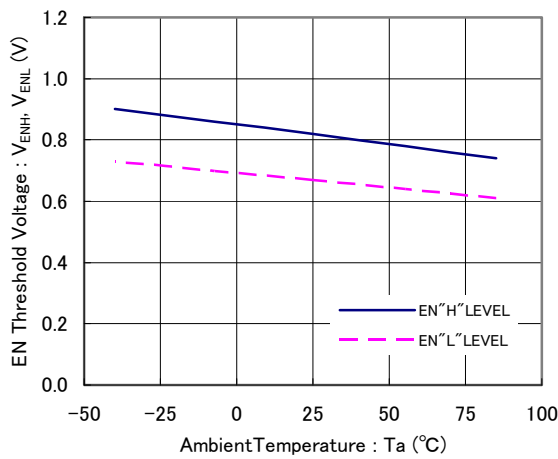


XC6419 VR2



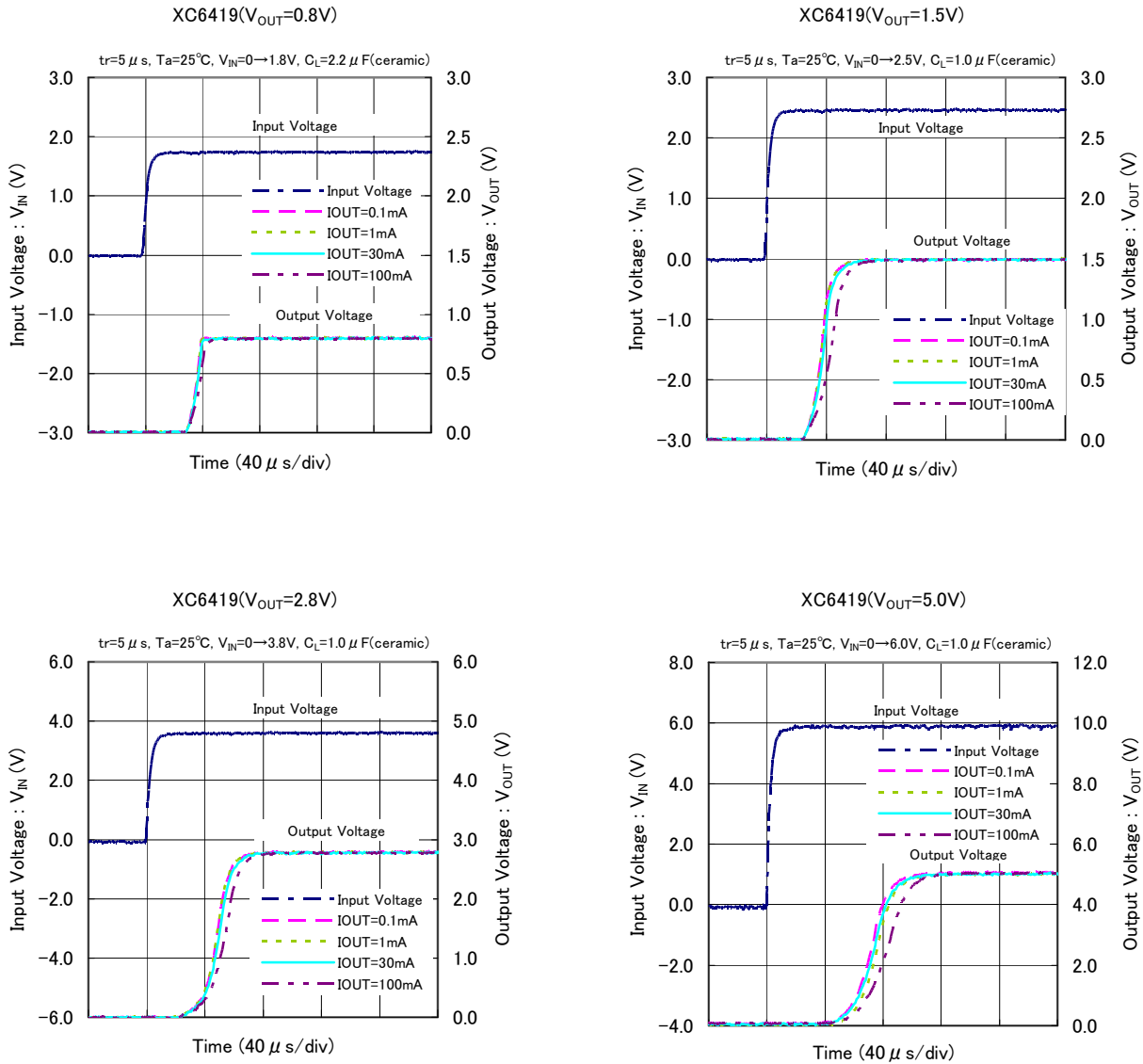
(7) EN Threshold Voltage vs. Ambient Temperature

XC6419

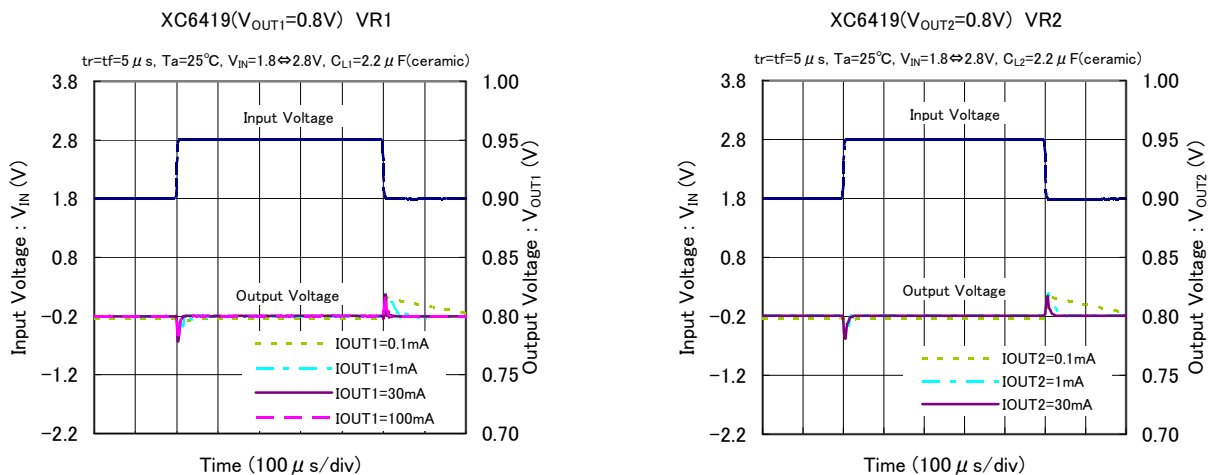


## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (8) Rising Response Time

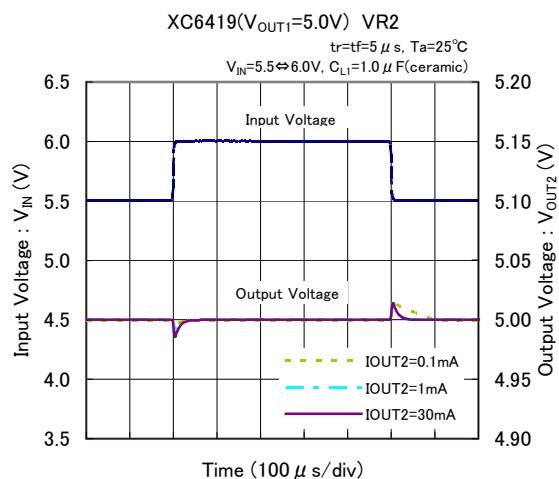
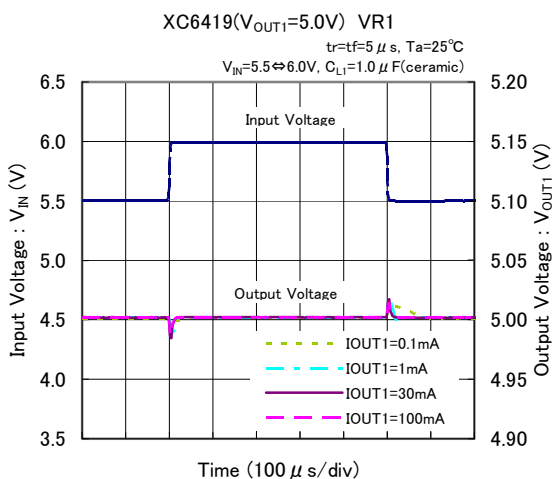
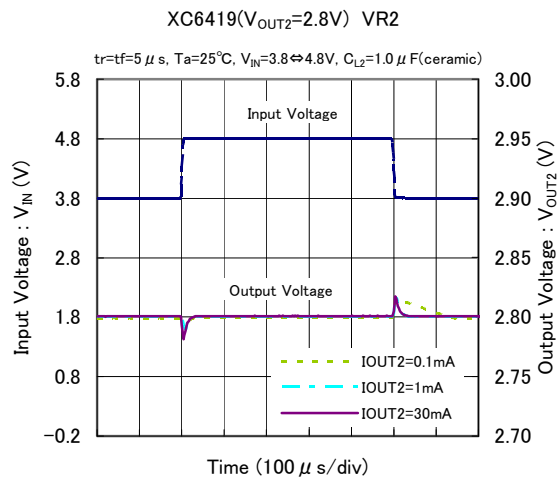
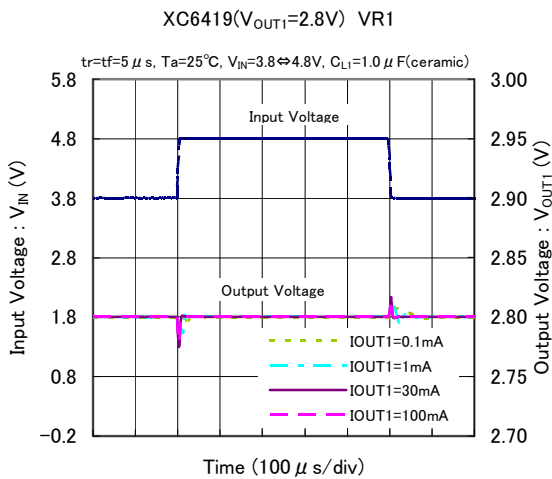
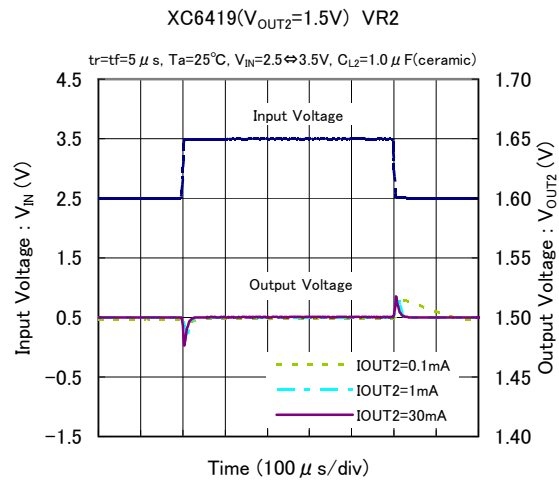
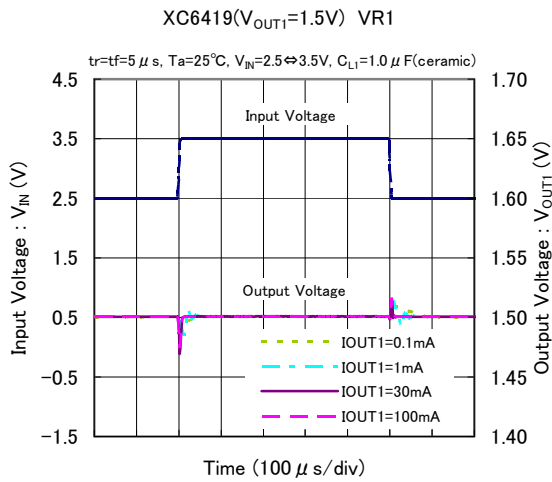


### (9) Input Transient Response



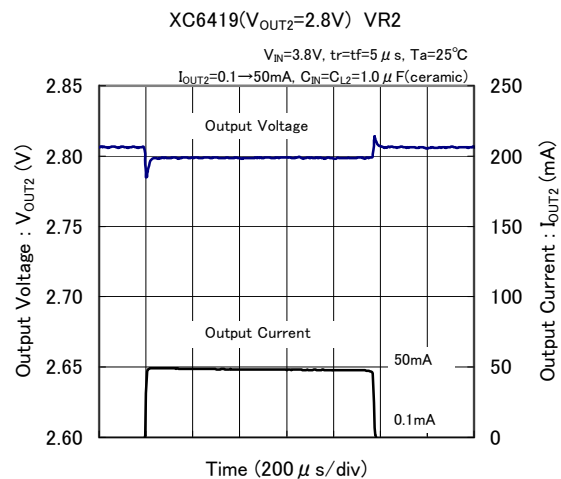
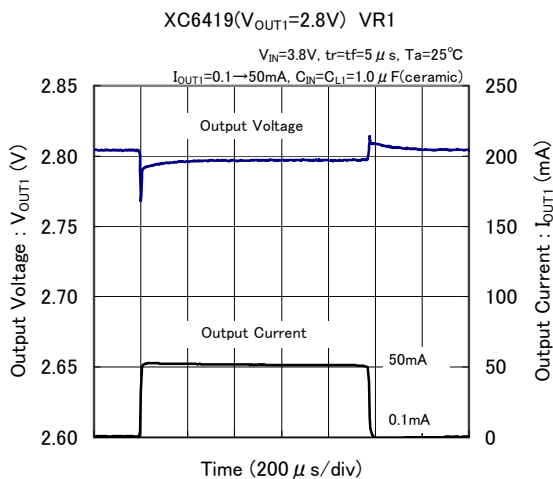
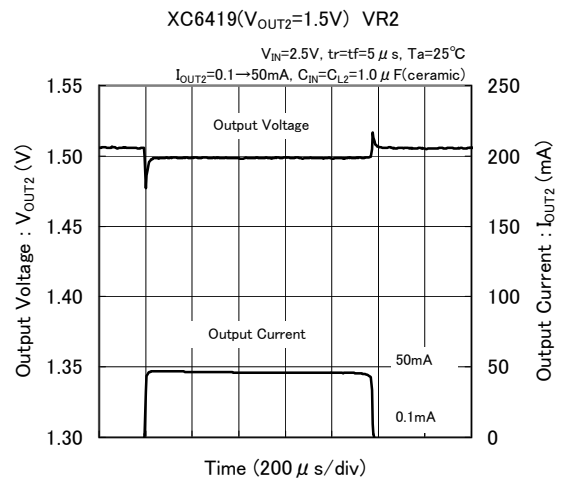
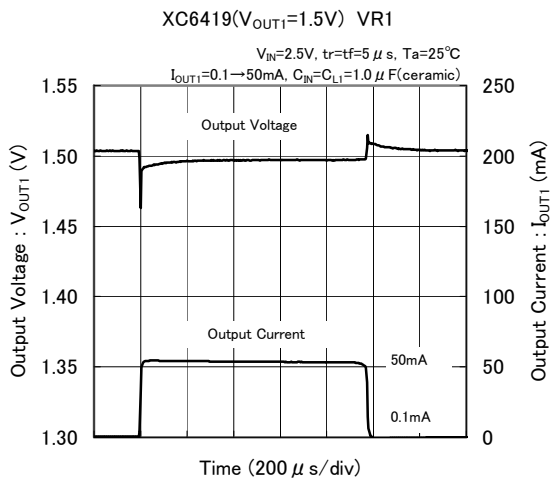
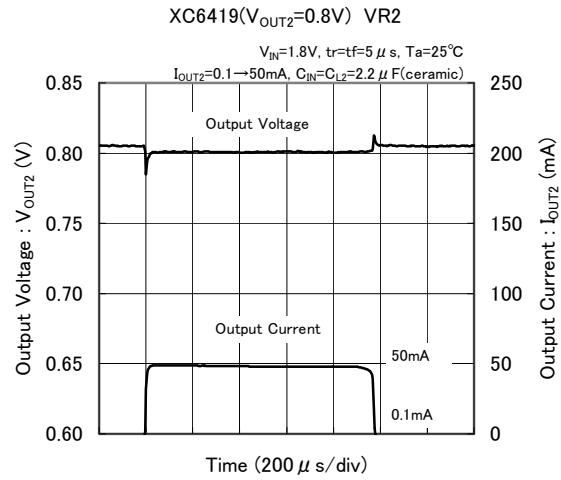
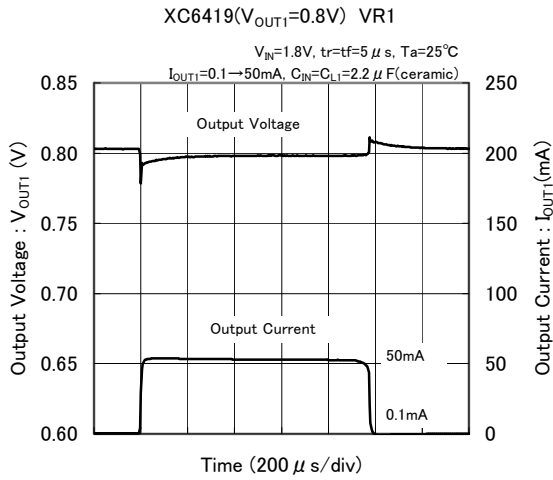
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (9) Input Transient Response (Continued)



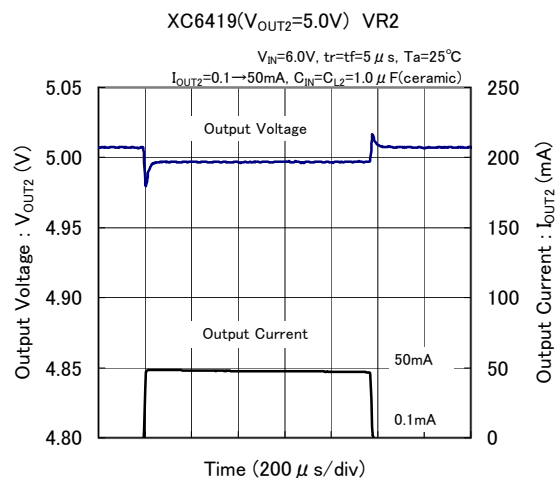
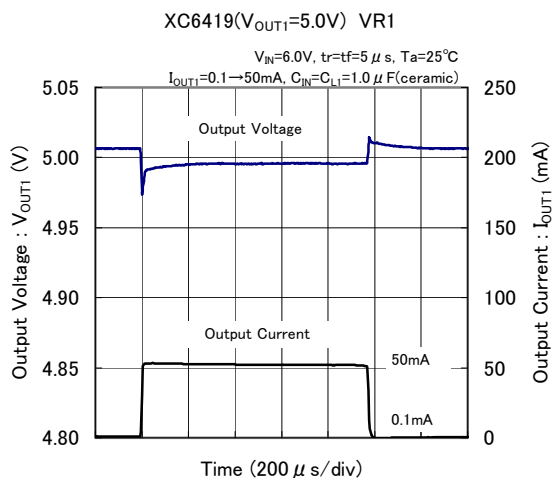
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (10) Load Transient Response

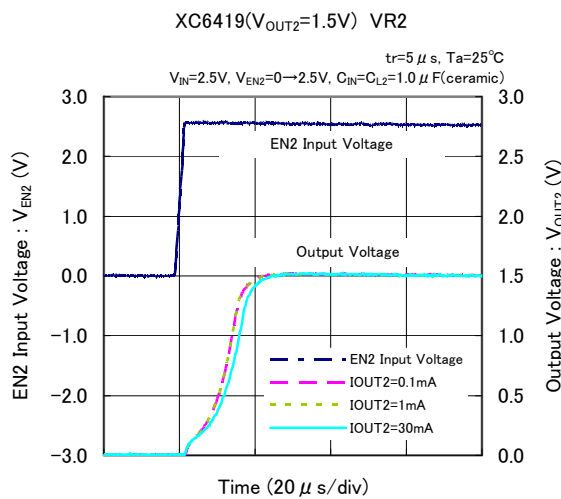
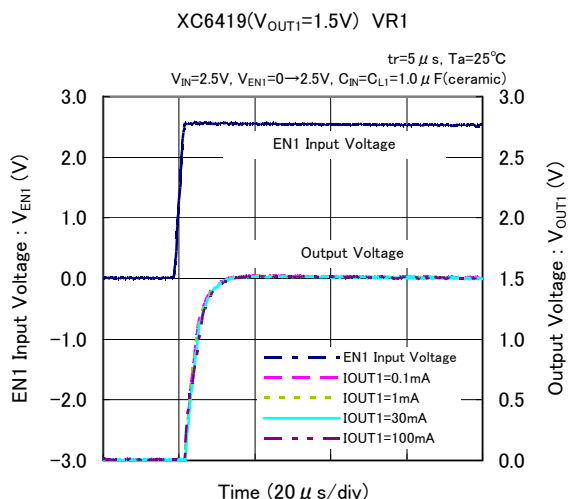
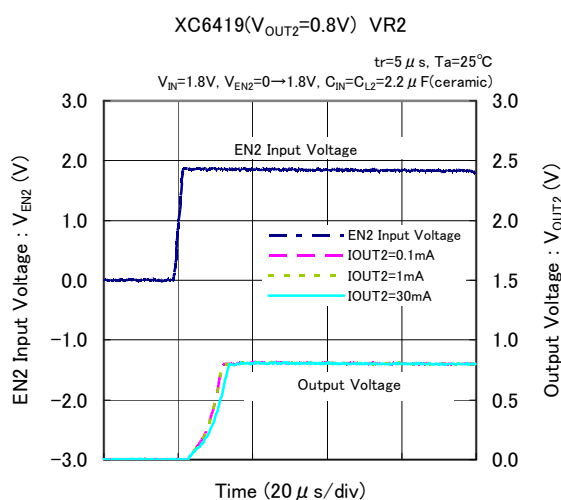
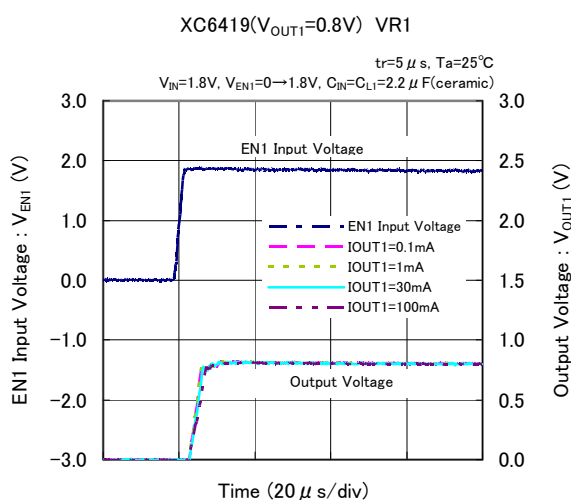


## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (10) Load Transient Response (Continued)



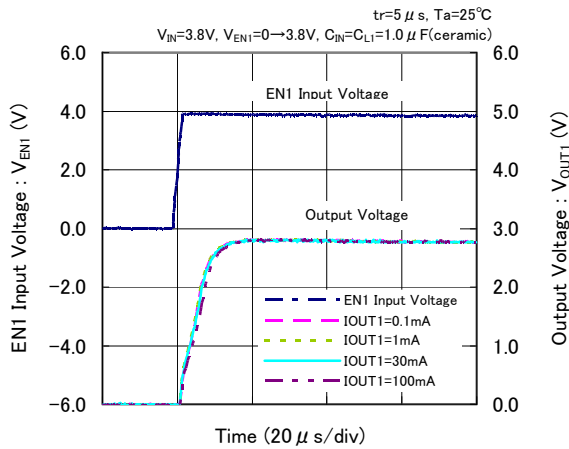
### (11) EN Rising Response Time



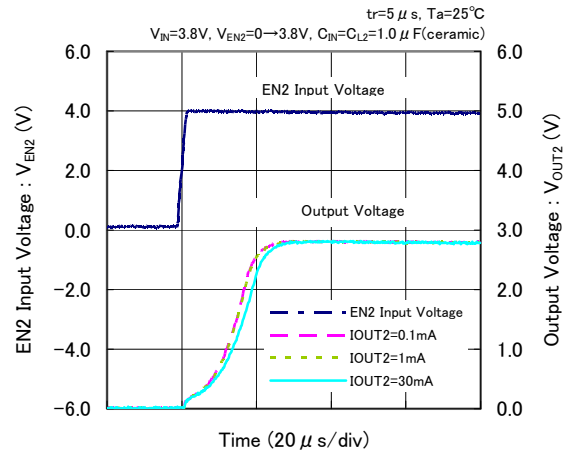
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (11) EN Rising Response Time (Continued)

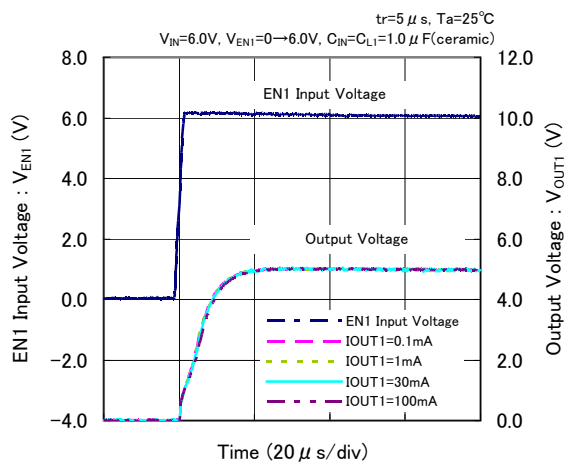
XC6419( $V_{OUT1}=2.8V$ ) VR1



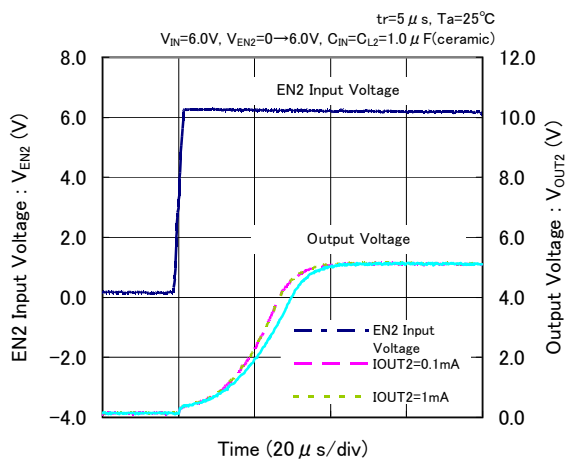
XC6419( $V_{OUT2}=2.8V$ ) VR2



XC6419( $V_{OUT1}=5.0V$ ) VR1

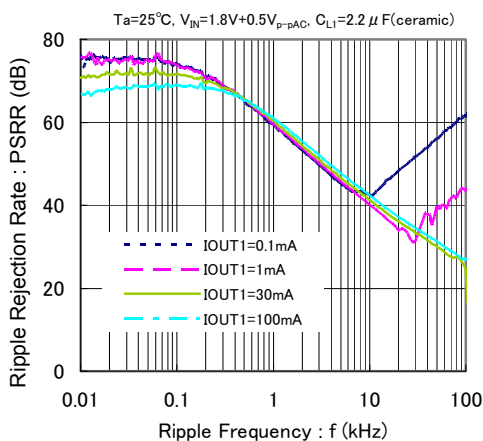


XC6419( $V_{OUT2}=5.0V$ ) VR2

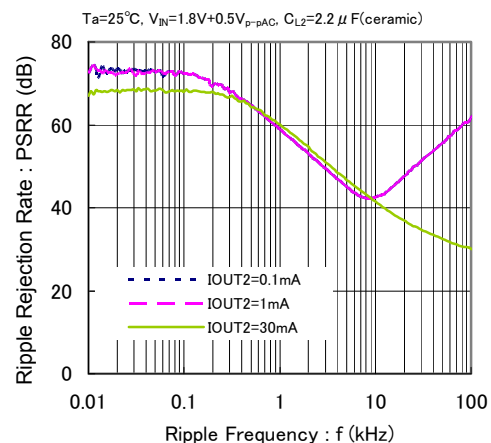


### (12) Ripple Rejection Rate

XC6419( $V_{OUT1}=0.8V$ ) VR1



XC6419( $V_{OUT2}=0.8V$ ) VR2

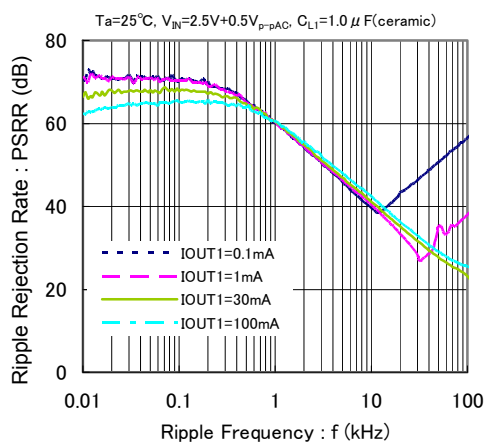




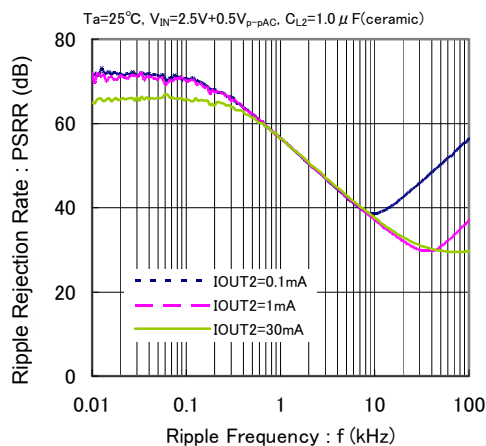
## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

### (12) Ripple Rejection Rate (Continued)

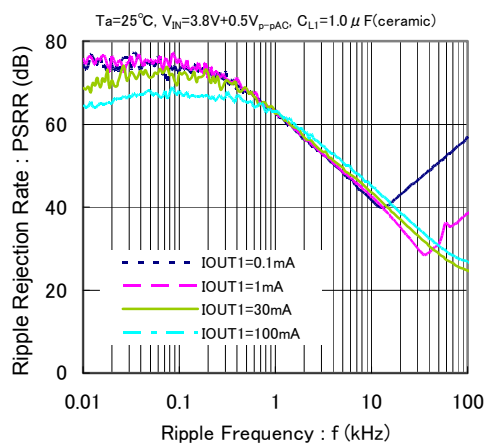
XC6419( $V_{OUT1}=1.5V$ ) VR1



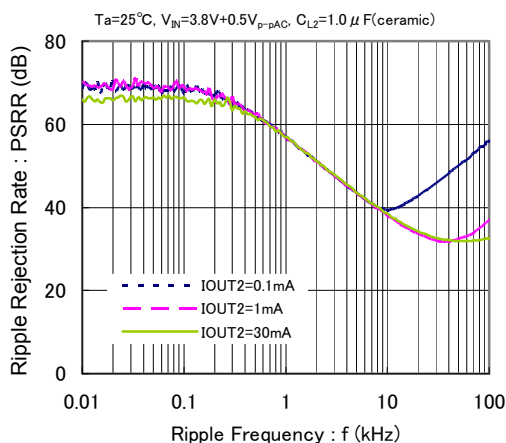
XC6419( $V_{OUT2}=1.5V$ ) VR2



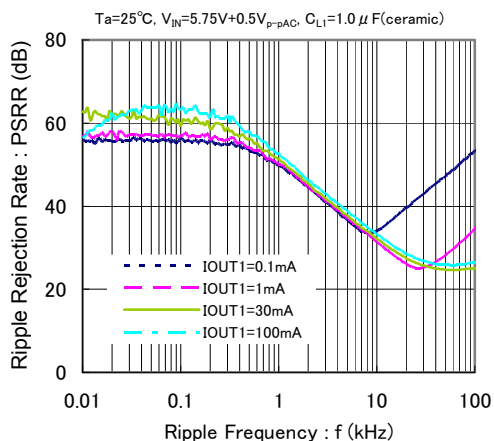
XC6419( $V_{OUT1}=2.8V$ ) VR1



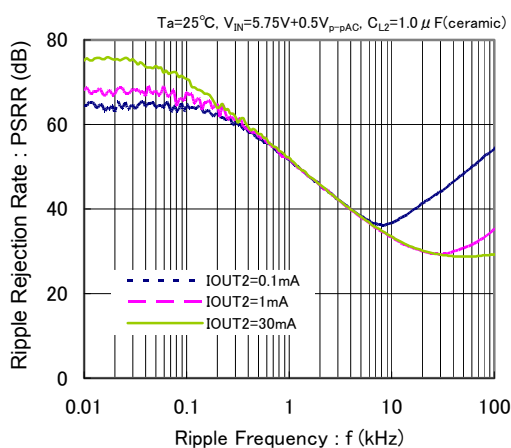
XC6419( $V_{OUT2}=2.8V$ ) VR2



XC6419( $V_{OUT1}=5.0V$ ) VR1

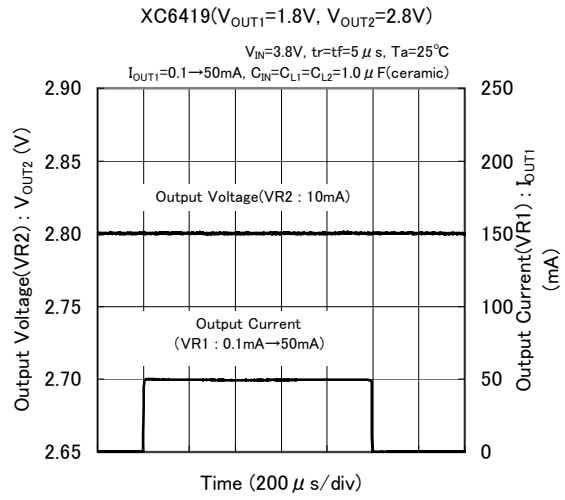
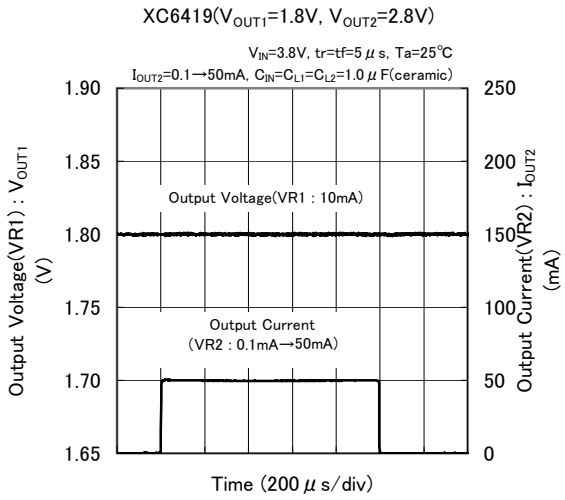


XC6419( $V_{OUT2}=5.0V$ ) VR2



## TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

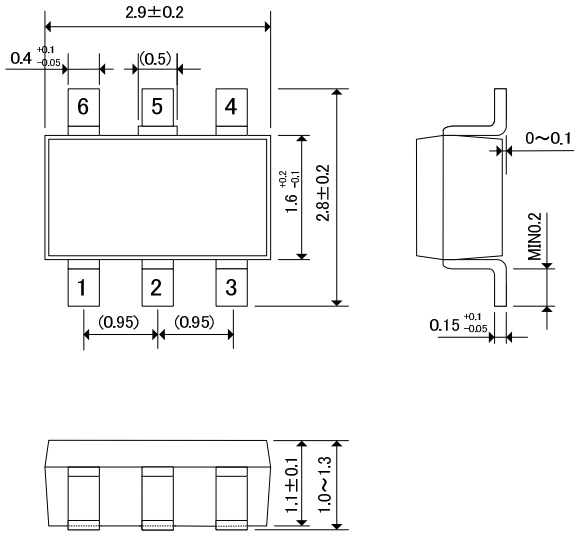
### (13) Cross Talk



# PACKAGING INFORMATION

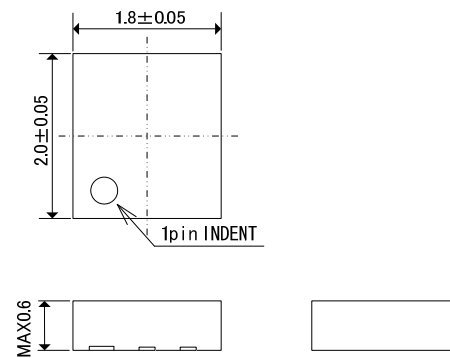
SOT-26

(unit : mm)

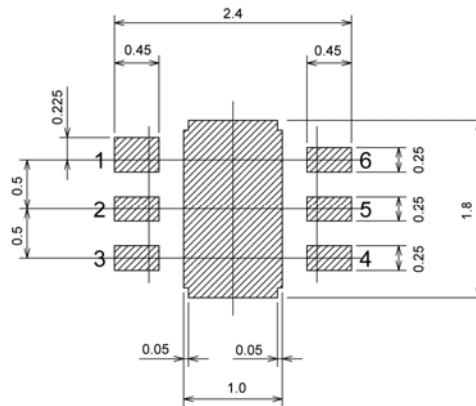


USP-6C

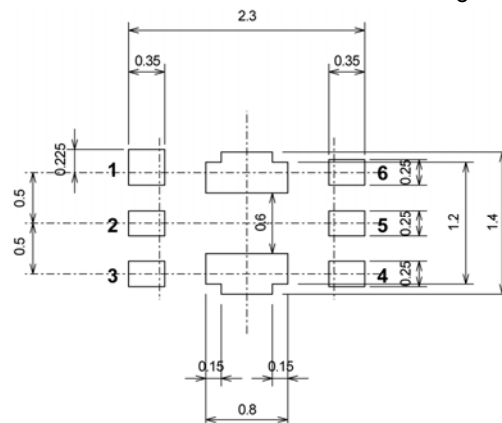
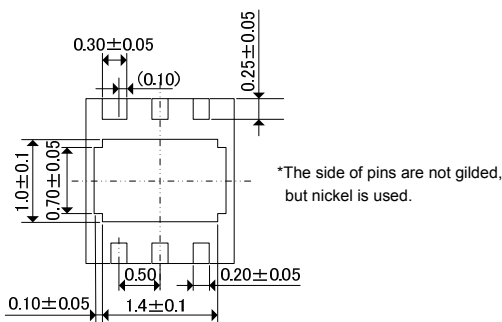
(unit : mm)



USP-6C Reference Pattern Layout



USP-6C Reference Metal Mask Design



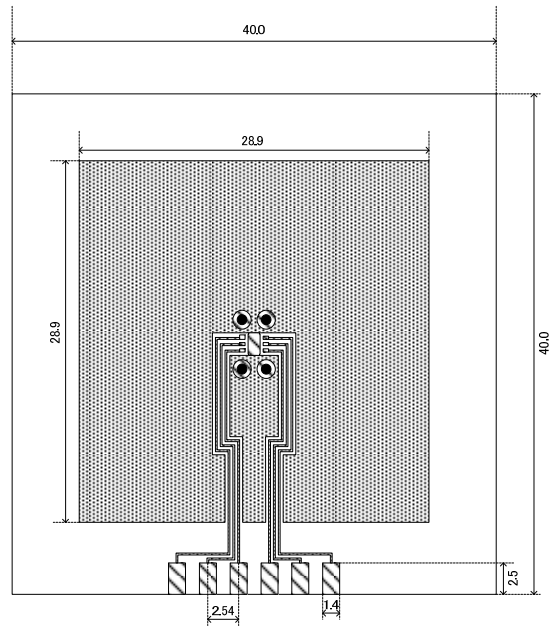
## PACKAGING INFORMATION (Continued)

### USP-6C Power Dissipation

Power dissipation data for the USP-6C is shown in this page.  
 The value of power dissipation varies with the mount board conditions.  
 Please use this data as one of reference data.

1. Measurement Condition (Reference data)

- Condition: Mount on a board
- Ambient: Natural convection
- Soldering: Lead (Pb) free
- Board: Dimensions 40 x 40 mm (1600 mm<sup>2</sup> in one side)  
 Copper (Cu) traces occupy 50% of the board area  
 In top and back faces  
 Package heat-sink is tied to the copper traces
- Material: Glass Epoxy (FR-4)
- Thickness: 1.6 mm
- Through-hole: 4 x 0.8 Diameter

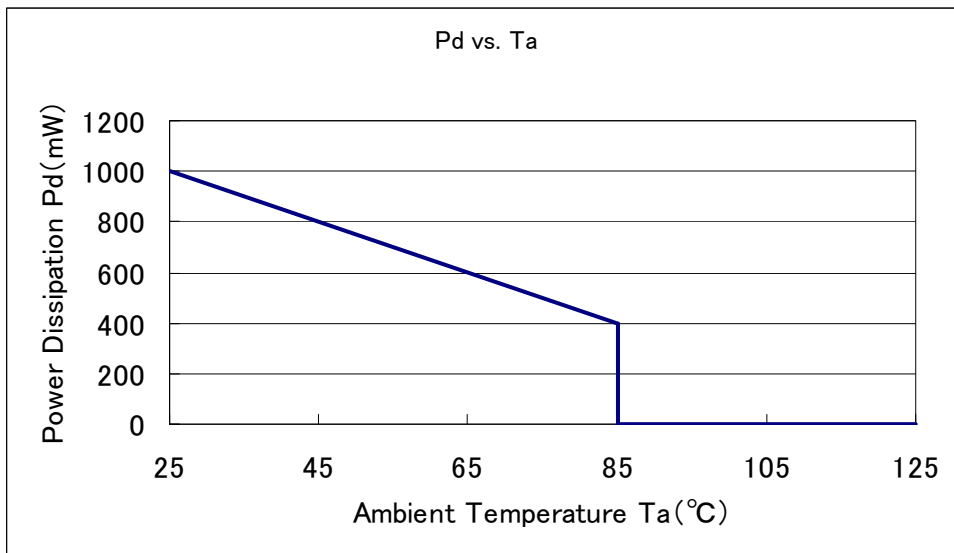


Evaluation Board (Unit: mm)

2. Power Dissipation vs. Operating temperature

Board Mount ( $T_j \text{ max} = 125$  )

Ambient Temperature (°C)	Power Dissipation Pd (mW)	Thermal Resistance (°C/W)
25	1000	100
85	400	



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